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| May 2019   | 2.1      | • Based on FSP EAS v2.0 – Backward compatibility is retained.  
• Added Dispatch Mode to ease integration with UEFI bootloaders.  
• FSP_INFO_HEADER changes  
  o Updated SpecVersion from 0x20 to 0x21  
  o Updated HeaderRevision from 3 to 4  
  o Defined bit 1 in ImageAttribute to indicate support for dispatch mode.  
• FSPM_ARCH_UPD changes  
  o Modified StackBase and StackSize to only contain FSP heap data during pre-memory phase.  
• FSP_STATUS_RESET_REQUIRED_* may now be returned by NotifyPhase()  
• Added description of dispatch mode boot flow  
• Added dispatch mode API definitions  
• Added FSP_ERROR_INFO & FSP_ERROR_INFO_HOB  
• Added EFI_PEI_GRAPHICS_DEVICE_INFO_HOB |
| April 2016 | 2.0      | • Based on FSP EAS v1.1a – Removed compatibility with v1.x  
• Updated FSP Binary format with FSP component information, layout, parsing and identification  
• FSP_INFO_HEADER changes  
  o Updated HeaderRevision from 2 to 3  
  o Reduced ImageAttribute field from 4 to 2 bytes  
  o Defined new ComponentAttribute field and defined ComponentType (Bits15:12)  
  o Defined Bit0 and Bit1 in ComponentAttribute for Debug/Release & Test/Official respectively  
  o Renamed Reserved to Reserved1  
  o Renamed ApiEntryNum to Reserved2  
  o Renamed FspInitEntryOffset to Reserved3  
  o Added SpecVersion at offset 11  
• Removed VPD configuration data and updated UPD configuration data & UPD common header structure  
• Added Reset Request status return types  
• Updated API sections to clarify optional API and calling order of API  
• Updated the input parameters of TempRamInit(), FspMemoryInit(), TempRamExit(), FspSiliconInit() and NotifyPhase() API  
• TempRamInit()  
  o Stack usage/stack allocation to bootloader clarified  
  o Calling convention exception clarified  
  o Removed parameter structure/description.  
  o Updated API parameters to use FSPT_UPD  
• FspMemoryInit() |
- Simplified the API and remove the parameter structures
- Minor clarification related to stack base and size and cleanup
- Defined Arch UPDs for FSP-M component FSPM_ARCH_UPD

- `TempRamExit()` - Updated API parameters
- `NotifyPhase()` - Added EndOfFirmware phase
- Clarified NVS HOB Fast Boot / S3 path
- Updated BootFlow diagram and added description

§
1 Introduction

1.1 Purpose

The purpose of this document is to describe the external architecture and interfaces provided in the Intel® Firmware Support Package (Intel® FSP). Implementation specific details are outside the scope of this document. Refer to Integration Guide for details.

1.2 Intended Audience

This document is targeted at all platform and system developers who need to generate or consume Intel® FSP binaries in their bootloader solutions. This includes, but is not limited to: System firmware or UEFI firmware or BIOS developers, bootloader developers, system integrators, as well as end users.

1.3 Related Documents

- Intel® FSP EAS version 2.0
- Boot Specification File (BSF) Specification
  https://firmware.intel.com/sites/default/files/BSF_1_0.pdf
- Unified Extensible Firmware Interface (UEFI) Specification
  http://www.uefi.org/specifications
- Platform Initialization (PI) Specification v1.7
  https://uefi.org/sites/default/files/resources/PI_Spec_1_7_final_Jan_2019.pdf
- Intel® Firmware Module Management Tool (Intel® FMMT) – available at https://firmware.intel.com/develop
## 1.4 Terminology

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<td>ACPI</td>
<td>Advanced Configuration and Power Interface</td>
</tr>
<tr>
<td>BCT</td>
<td>Binary Configuration Tool</td>
</tr>
<tr>
<td>BIOS</td>
<td>Basic Input Output System</td>
</tr>
<tr>
<td>BSP</td>
<td>Boot Strap Processor</td>
</tr>
<tr>
<td>BSF</td>
<td>Boot Setting File</td>
</tr>
<tr>
<td>FDF</td>
<td>Flash Description File</td>
</tr>
<tr>
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</tr>
<tr>
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<td>Firmware Support Package Interface(s)</td>
</tr>
<tr>
<td>FV</td>
<td>Firmware Volume</td>
</tr>
<tr>
<td>GUI</td>
<td>Graphical User Interface</td>
</tr>
<tr>
<td>GUID</td>
<td>Globally Unique IDentifier(s)</td>
</tr>
<tr>
<td>HOB</td>
<td>Hand Off Block(s)</td>
</tr>
<tr>
<td>PI</td>
<td>Platform Initialization</td>
</tr>
<tr>
<td>PIC</td>
<td>Position Independent Code</td>
</tr>
<tr>
<td>RAM</td>
<td>Random Access Memory</td>
</tr>
<tr>
<td>ROM</td>
<td>Read Only Memory</td>
</tr>
<tr>
<td>SMM</td>
<td>System Management Mode</td>
</tr>
<tr>
<td>SOC</td>
<td>System-On-Chip(s)</td>
</tr>
<tr>
<td>TOLUM</td>
<td>Top of low usable memory</td>
</tr>
<tr>
<td>TPM</td>
<td>Trusted Platform Module</td>
</tr>
<tr>
<td>UEFI</td>
<td>Unified Extensible Firmware Interface</td>
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<td>UPD</td>
<td>Updatable Product Data</td>
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2  Intel® FSP Overview

2.1  Design Philosophy

Intel recognizes that it holds the key programming information that is crucial for initializing Intel silicon. Some key programming information is treated as proprietary information and may only be available with legal agreements.

Intel® Firmware Support Package (Intel® FSP) is a binary distribution of necessary Intel silicon initialization code. The first design goal of the Intel® FSP is to provide ready access to the key programming information that is not publicly available. The second design goal is to abstract the complexities of Intel Silicon initialization and expose a limited number of well-defined interfaces.

A fundamental design philosophy is to provide the ubiquitously required silicon initialization code. As such, FSP will often provide only a subset of the product’s features.

2.2  Technical Overview

Intel® FSP provides chipset and processor initialization in a format that can easily be incorporated into many existing bootloaders.

Intel® FSP performs the necessary initialization steps as documented in the BIOS Writers Guide (BWG) / BIOS Specification including initialization of the processor, memory controller, chipset and certain bus interfaces, if necessary.

Intel® FSP is not a stand-alone bootloader; therefore it needs to be integrated into a bootloader to carry out other functions such as:

- Initializing non-Intel components
- Bus enumeration and device discovery
- Industry standards

2.2.1  Data Structure Descriptions

All data structures defined in this specification conform to the "little endian" byte order i.e., the low-order byte of a multibyte data items in memory is at the lowest address, while the high-order byte is at the highest address.

All reserved fields defined in this specification must be zero unless stated otherwise.
3 Intel® FSP Integration

The Intel® FSP binary can be integrated into many different bootloaders and embedded operating systems.

Below are some required steps for the integration:

- **Customizing**
  The Intel® FSP has configuration parameters that can be customized to meet the needs of the target platform.

- **Rebasing**
  The Intel® FSP is not Position Independent Code (PIC) and each FSP component has to be rebased if it is placed at a location which is different from the preferred base address specified during the FSP build.

- **Placing**
  Once the Intel® FSP binary is ready for integration, the bootloader needs to be modified to place this FSP binary at the specific base address identified above.

- **Interfacing**
  The bootloader needs to add code to setup the operating environment for the Intel® FSP, call the FSP API with the correct parameters, and parse the FSP output to retrieve the necessary information returned by the FSP.

3.1 Intel® FSP Distribution Package

The Intel® FSP distribution package contains the following:

- Intel® FSP Binary
- Integration Guide
- Data structure definitions
- Boot Settings File (BSF)

The Binary Configuration Tool (BCT) can be used to configure the FSP. BCT is available as a separate package.
4 **Intel® FSP Binary Format**

The Intel® FSP binary follows the *UEFI Platform Initialization Firmware Volume Specification* format. The Firmware Volume (FV) format is described in the *Platform Initialization (PI) Specification - Volume 3: Shared Architectural Elements* specification as referenced in Section 1.3 Related Documents.

Firmware Volume (FV) is a way to organize/structure binary components and enables a standardized way to parse the binary and handle the individual binary components that make up the Firmware Volume (FV).

Intel® FSP will have several components each containing one or more Firmware Volumes (FV). Each component provides a phase of initialization as below.

### 4.1.1 FSP-T: Temporary RAM initialization phase

Primary purpose of this phase is to initialize the Temporary RAM along with any other early initialization.

This phase consists of below FSP API

- `TempRamInit()`

### 4.1.2 FSP-M: Memory initialization phase

Primary purpose of this phase is to initialize the permanent memory along with any other early silicon initialization.

This phase consists of below FSP API

- `FspMemoryInit()`
- `TempRamExit()`

### 4.1.3 FSP-S: Silicon initialization phase

Primary purpose of this phase is to complete the silicon initialization including CPU and IO controller initialization.

This phase consists of below FSP API

- `FspSiliconInit()`
- `NotifyPhase()` - Post PCI bus enumeration, Ready To Boot and End of Firmware.
4.1.4 **OEM Components (FSP-O)**

An FSP may include optional OEM components that provide OEM extensibility. This component shall have an FSP_INFO_HEADER with component type in Image attribute field set to FSP-O.

4.2 **Intel® FSP Component Identification**

Each FSP component will have an FSP_INFO_HEADER as the first FFS file in the first Firmware Volume (FV). The FSP_INFO_HEADER will have an attribute field that can be used to identify that component as an FSP-T/FSP-M/FSP-S/FSP-O component.

There can be only one instance of the FSP-T / FSP-M / FSP-S in an FSP binary, while multiple instances of the FSP-O component are valid.

4.2.1 **Intel® FSP Image ID and Revision**

The FSP_INFO_HEADER structure inside each FSP component also contains an Image Identifier field and an Image Revision field that provide the identification and revision information for the FSP binary. It is important to verify these fields while integrating the FSP binary as the FSP configuration data could change over different FSP Image identifiers and revisions.

The FSP Image Identifier field should be the same for all the FSP components within the same FSP binary.

4.2.2 **Intel® FSP Component Layout**

All the FSP components are packaged back to back within the FSP and the size of each component is available in the component’s FSP_INFO_HEADER structure.

Furthermore, if there are multiple Firmware Volume(s) inside the FSP component, they are also packaged back to back. These components can be packaged in any order inside the FSP binary.
Figure 2: Intel® FSP Component Layout View

FSP Top

- FSP-T
- Temp RAM Phase Data
- FSP_INFO_HEADER - T

FSP-M

- Memory Init Phase Data
- FSP_INFO_HEADER - M

FSP-S

- Silicon Init Phase Data
- FSP_INFO_HEADER - S

FSP Base
Each Intel® FSP component has an **FSP_INFO_HEADER** table and may optionally have additional tables as described below.

All Intel® FSP tables must have a 4 byte aligned base address and a size that is a multiple of 4 bytes.

All Intel® FSP tables must be placed back-to-back.

All Intel® FSP tables must begin with a DWORD signature followed by a DWORD length field.

A generic table search algorithm for additional tables can be implemented with a signature search algorithm until a terminator signature ‘FSPP’ is found.

### 5.1.1 FSP_INFO_HEADER

The **FSP_INFO_HEADER** structure conveys the information required by the bootloader to interface with the Intel(R) FSP binary.

<table>
<thead>
<tr>
<th>Byte Offset</th>
<th>Size in Bytes</th>
<th>Field</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>4</td>
<td>Signature</td>
<td>‘FSPH’. Signature for the FSP_INFO_HEADER.</td>
</tr>
<tr>
<td>4</td>
<td>4</td>
<td>HeaderLength</td>
<td>Length of the header in bytes. The current value for this field is 72.</td>
</tr>
<tr>
<td>8</td>
<td>2</td>
<td>Reserved1</td>
<td>Reserved bytes for future.</td>
</tr>
<tr>
<td>10</td>
<td>1</td>
<td>SpecVersion</td>
<td>Indicates compliance with a revision of this specification in the BCD format.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>3 : 0 - Minor Version</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>7 : 4 - Major Version</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>For revision v2.1 the value will be 0x21</td>
</tr>
<tr>
<td>11</td>
<td>1</td>
<td>HeaderRevision</td>
<td>Revision of the header. The current value for this field is 4.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>The ImageRevision can be decoded as follows:</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>7 : 0 - Build Number</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>15 : 8 - Revision</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>23 : 16 - Minor Version</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>31 : 24 - Major Version</td>
</tr>
<tr>
<td>Byte Offset</td>
<td>Size in Bytes</td>
<td>Field</td>
<td>Description</td>
</tr>
<tr>
<td>-------------</td>
<td>---------------</td>
<td>------------</td>
<td>---------------------------------------------------------------------------------------------------</td>
</tr>
<tr>
<td>16</td>
<td>8</td>
<td>ImageId</td>
<td>8 ASCII character byte signature string that will help match the FSP binary to a supported hardware configuration. BootLoader should not assume null-terminated.</td>
</tr>
<tr>
<td>24</td>
<td>4</td>
<td>ImageSize</td>
<td>Size of this component in bytes.</td>
</tr>
<tr>
<td>28</td>
<td>4</td>
<td>ImageBase</td>
<td>Preferred base address for this component. If the FSP component is located at the address different from the preferred address, the FSP component needs to be rebased.</td>
</tr>
</tbody>
</table>
| 32          | 2             | ImageAttribute | Attributes of the FSP binary.  
  • Bit 0: Graphics Support – Set to 1 when FSP supports enabling Graphics Display.  
  • Bit 1: Dispatch Mode Support – Set to 1 when FSP supports the optional Dispatch Mode API defined in Section 7.2 and 9.  
  • Bits 15:2 - Reserved |
| 34          | 2             | ComponentAttribute | Attributes of the FSP Component  
  • Bit 0 – Build Type  
    0 – Debug Build  
    1 - Release Build  
  • Bit 1 – Release Type  
    0 - Test Release  
    1 - Official Release  
  • Bit 11:2 - Reserved  
  • Bits 15:12 – Component Type  
    0000 – Reserved  
    0001 – FSP-T  
    0010 – FSP-M  
    0011 – FSP-S  
    0100 to 0111 – Reserved  
    1000 – FSP-O  
    1001 to 1111 – Reserved |
<p>| 36          | 4             | CfgRegionOffset | Offset of the UPD configuration region. This offset is relative to the respective FSP Component base address. Please refer Section 6 for details. |
| 40          | 4             | CfgRegionSize | Size of the UPD configuration region. Please refer Section 6 for details.                           |
| 44          | 4             | Reserved2   | This value must be 0x00000000 if the FSP HeaderRevision is &gt;=3.                                     |</p>
<table>
<thead>
<tr>
<th>Byte Offset</th>
<th>Size in Bytes</th>
<th>Field</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>48</td>
<td>4</td>
<td>TempRamInitEntryOffset</td>
<td>Offset for the API to setup a temporary stack till the memory is initialized. If the value is set to 0x00000000, then this API is not available in this component.</td>
</tr>
<tr>
<td>52</td>
<td>4</td>
<td>Reserved3</td>
<td>This value must be 0x00000000 if the FSP HeaderRevision is &gt;=3.</td>
</tr>
<tr>
<td>56</td>
<td>4</td>
<td>NotifyPhaseEntryOffset</td>
<td>Offset for the API to inform the FSP about the different stages in the boot process. If the value is set to 0x00000000, then this API is not available in this component.</td>
</tr>
<tr>
<td>60</td>
<td>4</td>
<td>FspMemoryInitEntryOffset</td>
<td>Offset for the API to initialize the Memory. If the value is set to 0x00000000, then this API is not available in this component.</td>
</tr>
<tr>
<td>64</td>
<td>4</td>
<td>TempRamExitEntryOffset</td>
<td>Offset for the API to tear down the temporary memory. If the value is set to 0x00000000, then this API is not available in this component.</td>
</tr>
<tr>
<td>68</td>
<td>4</td>
<td>FspSiliconInitEntryOffset</td>
<td>Offset for the API to initialize the processor and chipset. If the value is set to 0x00000000, then this API is not available in this component.</td>
</tr>
</tbody>
</table>

## 5.1.2 FSP_INFO_EXTENDED_HEADER

The **FSP_INFO_EXTENDED_HEADER** structure conveys additional information about the FSP binary component. This allows FSP producers to provide additional information about the FSP instantiation.

### Table 2. FSP_INFO_EXTENDED_HEADER

<table>
<thead>
<tr>
<th>Byte Offset</th>
<th>Size in Bytes</th>
<th>Field</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>4</td>
<td>Signature</td>
<td>'FSPE'. Signature for the FSP_INFO_EXTENDED_HEADER.</td>
</tr>
<tr>
<td>4</td>
<td>4</td>
<td>Length</td>
<td>Length of the table in bytes, including all additional FSP producer defined data.</td>
</tr>
<tr>
<td>8</td>
<td>1</td>
<td>Revision</td>
<td>FSP producer defined revision of the table.</td>
</tr>
<tr>
<td>9</td>
<td>1</td>
<td>Reserved</td>
<td>Reserved for future use.</td>
</tr>
<tr>
<td>10</td>
<td>6</td>
<td>FspProducerId</td>
<td>FSP producer identification string.</td>
</tr>
<tr>
<td>16</td>
<td>4</td>
<td>FspProducerRevision</td>
<td>FSP producer implementation revision number. Larger numbers are assumed to be newer revisions.</td>
</tr>
</tbody>
</table>
### 5.1.3 Locating FSP_INFO_HEADER

The **FSP_INFO_HEADER** structure is stored in a firmware file, called the **FSP_INFO_HEADER** file and is placed as the first firmware file within each of the FSP component’s first Firmware Volume (FV). All firmware files will have a GUID that can be used to identify the files, including the **FSP_INFO_HEADER** file. The **FSP_INFO_HEADER** file GUID is `FSP_FFS_INFORMATION_FILE_GUID`

```c
#define FSP_FFS_INFORMATION_FILE_GUID \
 { 0x912740be, 0x2284, 0x4734, { 0xb9, 0x71, 0x84, 0xb0, 0x27, 0x35, 0x3f, 0xc } };
```

The bootloader can find the offset of the **FSP_INFO_HEADER** within the FSP component’s first Firmware Volume (FV) by the following steps described below:

- Use **EFI_FIRMWARE_VOLUME_HEADER** to parse the FSP FV header and skip the standard and extended FV header.

- The **EFI_FFS_FILE_HEADER** with the **FSP_FFS_INFORMATION_FILE_GUID** is located at the 8-byte aligned offset following the FV header.

- The **EFI_RAW_SECTION** header follows the FFS File Header.

- Immediately following the **EFI_RAW_SECTION** header is the raw data. The format of this data is defined in the **FSP_INFO_HEADER** and additional header structures.

A pictorial representation of the data structures that is parsed in the above flow is provided below.
Figure 3: Intel® FSP Component Headers

- Firmware Volume Header
- Firmware Volume Extended Header
- 8 Byte Alignment
- Firmware File 1
- Firmware File 2
- More Firmware Files
- Firmware File Section (Type RAW)
- RAW Section Header
- RAW Data has the FSP INFO Header
5.1.4 FSP Description File

An FSP component may optionally include an FSP description file. This file will provide information about the FSP including information about different silicon revisions the FSP supports. The contents of the FSP description file must be an ASCII encoded text string.

The file, if present, must have the following file GUID and be included in the FDF file as shown below.

```
#define FSP_FFS_INFORMATION_FILE_GUID \
{ 0xd9093578, 0x08eb, 0x44df, { 0xb9, 0xd8, 0xd0, 0xc1, 0xd3, 0xd5, 0x5d, 0x96 }};
#
# Description file
#
FILE RAW = D9093578-08EB-44DF-B9D8-D0C1D3D55D96 {
    SECTION RAW = FspDescription/FspDescription.txt
}
```

5.1.5 FSP Patch Table (FSPP)

FSP Patch Table contains offsets inside the FSP binary which store absolute addresses based on the FSP base. When the FSP is rebased the offsets listed in this table needs to be patched accordingly.

A PatchEntryNum of 0 is valid and indicates that there are no entries in the patch table and should be handled as a valid patch table by the rebasing software.

```
typedef struct {
    UINT32  Signature;   ///< FSP Patch Table Signature “FSPP”
    UINT16  Length;      ///< Size including the PatchData
    UINT8   Revision;    ///< Revision is set to 0x01
    UINT8   Reserved;
    UINT32  PatchEntryNum; ///< Number of entries to Patch
    UINT32  PatchData[]; ///< Patch Data
} FSP_PATCH_TABLE;
```

<table>
<thead>
<tr>
<th>BIT [23:00]</th>
<th>Image OFFSET to patch</th>
</tr>
</thead>
<tbody>
<tr>
<td>BIT [27:24]</td>
<td>Patch type</td>
</tr>
<tr>
<td>0000: Patch DWORD at OFFSET with the delta of the new and old base.</td>
<td></td>
</tr>
<tr>
<td>1111: Same as 0000</td>
<td></td>
</tr>
<tr>
<td>Others: Reserved</td>
<td></td>
</tr>
</tbody>
</table>

| BIT [28:30] | Reserved |

Table 3. FSPP – PatchData Encoding
5.1.5.1 Example

Let’s assume the FSP image size is 0x38000. And we need to rebase the FSP base from 0xFFFFC000 to 0xFFF00000.

Below is an example of the typical implementation of the FSP_PATCH_TABLE:

```c
FSP_PATCH_TABLE mFspPatchTable =
{
    0x50505346,              // Signature (FSPP)
    16,                      // Length;
    0x01,                    // Revision;
    0x00,                    // Reserved;
    1,                       // PatchEntryNum;
    {
        0xFFFFFFFC      // Patch FVBASE at end of FV
    }
};
```

Looking closer at the patch table entries:

```c
0xFFFFFFFC,      // Patch FVBASE at end of FV
```

The image offset to patch in the FSP image is indicated by BIT[23:0], 0xFFFFFC. Since BIT[31] is 1, the actual FSP image offset to patch should be:

\[
\text{ImageSize} - (0x1000000 - 0xFFFFFC) = 0x38000 - 4 = 0x37FFC
\]

If the DWORD at offset 0x37FFC in the original FSP image is 0xFFF00000, then the new value should be:

\[
\text{OldValue} + (\text{NewBase} - \text{OldBase}) = 0xFFF00000 + (0xFFF00000 - 0xFFF00000) = 0xFFF00000
\]

Thus the DWORD at FSP image offset 0x37FFC should be patched to xFFF00000 after the rebasing.
Each Intel® FSP module contains a configurable data region which can be used by the FSP during initialization. This configuration region is a data structure called the Updateable Product Data (UPD) and will contain the default parameters for FSP initialization. The UPD data structure is only used by the FSP when the FSP is being invoked using the API mode interface defined in Section 8.

When the FSP is invoked according to the dispatch mode interface defined in Section 9, the UPD configuration region and the UPD data structure are not used by the FSP. In dispatch mode, the PPI database and PCD database are shared between the bootloader and the FSP. Because they are shared, the UPD configuration region is not needed to provide a mechanism to pass configuration data from the bootloader to the FSP. Instead, configuration data is communicated to the FSP using PCD and PPI. The bootloader may utilize the UPD to influence PCD and PPI contents provided to the FSP in dispatch mode.

The UPD parameters can be statically customized using a separate Binary Configuration Tool (BCT). There will be a Boot Setting File (BSF) provided along with FSP binary to describe the configuration options within the FSP. This file contains the detailed information on all configurable options, including description, help information, valid value range and the default value.

The UPD data can also be dynamically overridden by the bootloader during runtime in addition to static configuration. Platform limitations like lack of updateable memory before calling TempRamInit() API may pose restrictions on the FSP-T data runtime update. Any such restrictions will be documented in the Integration Guide.

The UPD data is organized as a structure. The TempRamInit(), FspMemoryInit() and FspSiliconInit() API parameters include a pointer which can be initialized to point to the UPD data structure. If this pointer is initialized to NULL when calling these API, the FSP will use the default built-in UPD configuration data in the respective FSP components. However, if the bootloader needs to update any of the UPD parameters, it is recommended to copy the whole UPD structure from the FSP component to memory, update the parameters and initialize the UPD pointer to the address of the updated UPD structure. The FSP API will then use this data structure instead of the default configuration region data for platform initialization. The UPD data structure is a project specific structure. Please refer to the Integration Guide for the details of this structure.

The UPD structure has some standard fields followed by platform specific parameters and the UPD structure definition will be provided as part of the FSP distribution package.
6.1 UPD Standard Fields

The first few fields of the UPD Region are standard for all FSP implementations as documented below.

<table>
<thead>
<tr>
<th>Offset</th>
<th>Field</th>
</tr>
</thead>
<tbody>
<tr>
<td>0x00 – 0x07</td>
<td>UPD Region Signature. The signature will be</td>
</tr>
<tr>
<td></td>
<td>“XXXXXX_T” for FSP-T</td>
</tr>
<tr>
<td></td>
<td>“XXXXXX_M” for FSP-M</td>
</tr>
<tr>
<td></td>
<td>“XXXXXX_S” for FSP-S</td>
</tr>
<tr>
<td></td>
<td>Where XXXXXX is an unique signature</td>
</tr>
<tr>
<td>0x08</td>
<td>Revision of the Data structure</td>
</tr>
<tr>
<td>0x09 – 0x1F</td>
<td>Reserved[23]</td>
</tr>
<tr>
<td>0x20 – n</td>
<td>Platform Specific Parameters, where the n is equal to</td>
</tr>
<tr>
<td></td>
<td>(FSP_INFO_HEADER.CfgRegionSize – 1)</td>
</tr>
</tbody>
</table>

```c
typedef struct {
    UINT64                      Signature;
    UINT8                       Revision;
    UINT8                       Reserved[23];
} FSP_UPD_HEADER;
```

6.1.1 FSP-T UPD Structure

The UPD data structure definition for the FSP-T component will be provided as part of the FSP release package and documented in the integration guide as well.

```c
typedef struct {
    FSP_UPD_HEADER       UpdHeader;

    /**
     * Platform specific parameters
     **/
    ...
} FSPT_UPD;
```
6.1.2 FSP-M UPD Structure

The UPD data structure definition for the FSP-M component will be provided as part of the FSP release package and documented in the integration guide as well.

```c
typedef struct {
    FSP_UPD_HEADER UpdHeader;
    FSPM_ARCH_UPD FspmArchUpd;

    /**
     * Platform specific parameters
     **/
     ...
} FSPM_UPD;

typedef struct {
    UINT8 Revision;
    UINT8 Reserved[3]
    VOID *NvsBufferPtr;
    VOID *StackBase;
    UINT32 StackSize;
    UINT32 BootLoaderTolumSize;
    UINT32 BootMode;
    UINT8 Reserved[8];
} FSPM_ARCH_UPD;
```

<table>
<thead>
<tr>
<th><strong>Revision</strong></th>
<th>Revision of the structure is 1 for this version of the specification.</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>NvsBufferPtr</strong></td>
<td>Pointer to the non-volatile storage (NVS) data buffer. If it is <strong>NULL</strong> it indicates the NVS data is not available. Refer to Section 10.2 for more details.</td>
</tr>
<tr>
<td><strong>StackBase</strong></td>
<td>Pointer to the temporary RAM base address to be consumed inside <code>FspMemoryInit()</code> API. For FSP implementations compliant to v2.0 of this specification, the temporary RAM is used to establish a stack and a HOB heap. For FSP implementations compliant to v2.1 of this specification, the temporary RAM is only used for a HOB heap. Starting with v2.1 of this specification, FSP will run on top of the stack provided by the bootloader instead of establishing a separate stack. This allows the stack memory to be reused after <code>FspMemoryInit()</code> returns to the bootloader. To retain backwards compatibility with earlier versions of this specification, this parameter retains the <code>StackBase</code> name.</td>
</tr>
</tbody>
</table>
### StackSize

For FSP implementations compliant to v2.0 of this specification, the temporary RAM size used to establish a stack and HOB heap. Consumed by the `FspMemoryInit()` API.

For FSP implementations compliant to v2.1 of this specification, the temporary RAM size used to establish a HOB heap inside the `FspMemoryInit()` API.

Starting with v2.1 of this specification, FSP will run on top of the stack provided by the bootloader instead of establishing a separate stack. This allows the stack memory to be reused after `FspMemoryInit()` returns to the bootloader. To retain backwards compatibility with earlier versions of this specification, this parameter retains the `StackSize` name.

Refer to the *Integration Guide* for the minimum required temporary RAM size. In the case of FSP v2.1, the *Integration Guide* shall also specify the minimum free stack space required at the point where the FSP API entrypoints are called.

### BootloaderTolumSize

Size of memory to be reserved by FSP below "top of low usable memory" for bootloader usage. Refer to Section 10.3 for more details.

### BootMode

Current boot mode. Values are defined in *Section 12.1 Appendix A – Data Structures*. Refer to the *Integration Guide* for supported boot modes.

#### 6.1.3 FSP-S UPD Structure

The UPD data structure definition for the FSP-S component will be provided as part of the FSP release package and documented in the integration guide as well.

```c
typedef struct {
    FSP_UPD_HEADER UpdHeader;

    /**
     * Platform specific parameters
     **/
    ...
} FSPS_UPD;
```
The Intel® FSP v2.1 specification defines two possible FSP boot flows. The first boot flow is the "API mode" boot flow. This boot flow is identical to the boot flow defined in the Intel® FSP v2.0 specification. This specification also defines the "dispatch mode" boot flow. It is not required for a specific implementation of FSP to support the dispatch mode boot flow. The API mode boot flow is mandatory for all FSP implementations. **FSP_INFO_HEADER** indicates if dispatch mode is supported by the FSP.

### 7.1 API Mode Boot Flow

**Figure 4: API Mode Boot Flow**
7.1.1 Boot Flow Description

1. Bootloader starts executing from Reset Vector.
   a) Switches the mode to 32-bit mode.
   b) Initializes the early platform as needed.
   c) Finds FSP-T and calls the TempRamInit() API. The bootloader also has the option to initialize the temporary memory directly, in which case this step and step 2 are skipped.

2. FSP initializes temporary memory and returns from TempRamInit() API.

3. Bootloader initializes the stack in temporary memory.
   a) Initializes the platform as needed.
   b) Finds FSP-M and calls the FspMemoryInit() API.

4. FSP initializes memory and returns from FspMemoryInit() API.

5. Bootloader relocates itself to Memory.

6. Bootloader calls TempRamExit() API. If Bootloader initialized the temporary memory in step 1.c)... this step and the next step are skipped.

7. FSP returns from TempRamExit() API.

8. Bootloader finds FSP-S and calls FspSiliconInit() API.

9. FSP returns from FspSiliconInit() API.

10. Bootloader continues and device enumeration.


12. Bootloader calls NotifyPhase() API with ReadyToBoot parameter before transferring control to OS loader.

13. When booting to a non-UEFI OS, Bootloader calls NotifyPhase() API with EndOfFirmware parameter immediately after ReadyToBoot.

14. When booting to a UEFI OS, Bootloader calls NotifyPhase() with EndOfFirmware parameter during ExitBootServices.

**Note:** If FSP returns the reset required status in any of the API, then bootloader performs the reset. Refer to the Integration Guide for more details on Reset Types.
7.2 Dispatch Mode Boot Flow

Dispatch mode is an optional boot flow intended to enable FSP to integrate well in to UEFI bootloader implementations. Implementation of this boot flow necessitates that the underlying FSP implementation uses the Pre-EFI Initialization (PEI) environment defined in the PI Specification. It is possible to implement an FSP without using PEI, so bootloaders must check that dispatch mode is available using the FSP_INFO_HEADER, see Section 5.1.1 for further details. The Integration Guide will also specify if an FSP implements dispatch mode. See Section 9 for a full description of dispatch mode.

7.2.1 High Level Overview

Figure 5: Dispatch Mode Boot Flow

Blue blocks are from the FSP binary and green blocks are from the bootloader. Blocks with mixed colors indicate that both bootloader and FSP modules are dispatched during that phase of the boot flow.

Dispatch mode is intended to implement a boot flow that is as close to a standard UEFI boot flow as possible. In dispatch mode, FSP exposes Firmware Volumes (FV) directly to the bootloader. The PEIM in these FV are executed directly in the context of the PEI environment provided by the bootloader. FSP-T, FSP-M, and FSP-S could contain one or multiple FVs. The exact FVs layout will be described in the Integration Guide. In dispatch mode, the PPI database, PCD database, and HOB list are shared between the bootloader and the FSP.

In dispatch mode, the NotifyPhase() API is not used. Instead, FSP-S contains DXE drivers that implement the native callbacks on equivalent events for each of the NotifyPhase() invocations.
7.2.2 **Boot Flow Description**

This boot flow assumes that the bootloader is a typical UEFI firmware implementation conforming to the *PI Specification*. Therefore, the bootloader will follow the standard four phase PI boot flow progressing from SEC phase, to PEI phase, to DXE phase, to BDS phase.

1. Bootloader provided SEC phase starts executing from Reset Vector.
   a) Switches the mode to 32-bit mode.
   b) Initializes the early platform as needed.
   c) Finds FSP-T and calls the *TempRamInit()* API. SEC also has the option to initialize the temporary memory directly, in which case this step and step 2 are skipped.

2. FSP initializes temporary memory and returns from *TempRamInit()* API.

3. SEC initializes the stack in temporary memory.

4. SEC finds FSP-M and adds an instance of 
   
   **EFI_PEI_CORE_FV_LOCATION_PPI** containing the address of FSP-M to the PpiList passed in to PEI core.

5. SEC calls the entry point for the PEI core inside FSP-M.
   a) Bootloader passes the FSP-M PEI core a **EFI_SEC_PEI_HAND_OFF** data structure with the *BootFirmwareVolumeBase* and *BootFirmwareVolumeSize* members pointing to a FV provided by the platform.
      - The bootloader provides the Boot Firmware Volume (BFV). Consequently, in FSP dispatch mode PEI core is not in the BFV unlike most UEFI firmware implementations.

6. PEI core dispatches the PEIM in the BFV provided by the bootloader.

7. Bootloader installs **FSPM_ARCH_CONFIG_PPI**.

8. One of the PEIM provided by the bootloader installs a **EFI_PEI_FIRMWARE_VOLUME_INFO_PPI** for each FV contained in FSP-M.
   a) The bootloader must not install the **EFI_PEI_FIRMWARE_VOLUME_INFO_PPI**(s) for FSP-M until the bootloader is ready for FSP-M to execute.
   b) If FSP-M requires any DynamicEx PCD values, the bootloader must ensure those PCD contain valid data before installing the **EFI_PEI_FIRMWARE_VOLUME_INFO_PPI**(s) for FSP-M.

9. PEI core will continue to dispatch PEIM. During the course of dispatch, PEIM included with FSP-M will be executed.
a) Some of the PEIM contained in FSP-M may require configuration data to be provided by the bootloader. If this is the case, the configuration data may be stored in either DynamicEx PCD or PPI.

- If the configuration data is stored in PCD, then it is assumed that the PCD contain valid data before FSP-M begins execution.

- If the configuration data is stored in PPI, then the needed PPI will either be in the PEIM’s DEPEX, or the PEIM will register a callback for the needed PPI and not attempt to access the PPI until the callback is invoked by PEI core.

10. FSP-M installs `FSP_TEMP_RAM_EXIT_PPI`.

11. After dispatching the PEIM in FSP-M, memory will be initialized. Accordingly, FSP-M will call `(*PeiServices)->InstallPeiMemory()`.

a) PEI core shadows to main memory.

b) PEI core invokes `TemporaryRamDone()` from `EFI_PEI_TEMPORARY_RAM_DONE_PPI`. The implementation of `EFI_PEI_TEMPORARY_RAM_DONE_PPI` is provided by the bootloader.

c) The bootloader implementation of `EFI_PEI_TEMPORARY_RAM_DONE_PPI` calls `TempRamExit()` from `FSP_TEMP_RAM_EXIT_PPI`.

- For platforms that use the SEC implementation in UefiCpuPkg, SEC core implements `EFI_PEI_TEMPORARY_RAM_DONE_PPI`. The `TemporaryRamDone()` implementation in SEC core will call `SecPlatformDisableTemporaryMemory()`. This function would then locate `FSP_TEMP_RAM_EXIT_PPI` and call `TempRamExit()`.

- If the bootloader did not call `TempRamInit()` in step 1.c) then the bootloader would not call `TempRamExit()`.

d) PEI core follows up with an installation of the `EFI_PEI_PERMANENT_MEMORY_INSTALLED_PPI`. Refer to Volume 1 of the PI Specification for details.

12. Post memory PEIM provided by the bootloader are now executed.

13. One of the PEIM provided by the bootloader installs a `EFI_PEI_FIRMWARE_VOLUME_INFO_PPI` for each FV contained in FSP-S.

a) The bootloader must not install the `EFI_PEI_FIRMWARE_VOLUME_INFO_PPI(s)` for FSP-S until the bootloader is ready for FSP-S to execute.

b) If FSP-S requires any DynamicEx PCD values, the bootloader must ensure those PCD contain valid data before installing the `EFI_PEI_FIRMWARE_VOLUME_INFO_PPI(s)` for FSP-S.
14. PEI core will continue to dispatch PEIM. During the course of dispatch, PEIM included with FSP-S will be executed.

   a) Some of the PEIM contained in FSP-S may require configuration data to be provided by the bootloader. If this is the case, the configuration data may be stored in either DynamicEx PCD or PPI.

      ▪ If the configuration data is stored in PCD, then it is assumed that the PCD contain valid data before FSP-S begins execution.

      ▪ If the configuration data is stored in PPI, then the needed PPI will either be in the PEIM’s DEPEX, or the PEIM will register a callback for the needed PPI and not attempt to access the PPI until the callback is invoked by PEI core.

15. End of PEI is reached, and DXE begins execution.

16. Any DXE drivers included in FSP-S are dispatched. These drivers may create events to be notified at different points in the boot flow. FSP shall use a subset of the events defined by the PI Specification, see Section 9.3 for the full list of events the FSP may use.

17. DXE signals EFI_END_OF_DXE_EVENT_GROUP_GUID and transitions to BDS phase.

   a) Note: The PI Specification does not require that Step 17 occurs before Step 18, however most implementations appear to use this order.

18. BDS starts the PCI bus driver, which enumerates PCI devices. After enumeration, the PCI bus driver installs the EFI_PCI_ENUMERATION_PROTOCOL. DXE signals any applicable events.

19. BDS signals EFI_EVENT_GROUP_READY_TO_BOOT immediately before loading the OS boot loader.

20. BDS executes the OS boot loader. The OS boot loader loads the OS kernel into memory.

21. The OS boot loader calls ExitBootServices(), DXE signals this event before shutting down the UEFI Boot Services.

7.2.3 Alternate Boot Flow Description

In some scenarios, the bootloader may wish to use a customized version of the PEI Foundation. For example, many software debugger implementations need to be linked with PEI core directly. For this reason, as an alternative to using the PEI core included with FSP-M, the bootloader may instead elect to use its own implementation of PEI core. In this case, the bootloader provided SEC will not produce the EFI_PEI_CORE_FV_LOCATION_PPI, and instead of calling the entry point for the PEI core inside FSP-M it shall call the entry point for the PEI core inside the BFV. Note that this will result in two copies of PEI core being present in the final image, one in the BFV and one in the FSP-M. If firmware storage space is under pressure, one may elect to post process FSP-M using Intel® FMMT to remove the PEI core included with FSP.
This is generally considered to be a debug feature, and is discouraged for use in a production environment as it deviates from the boot flow that receives the most validation. It is also inefficient due to the duplicate copy of PEI core it introduces.

1. Bootloader provided SEC phase starts executing from Reset Vector.
   a) Switches the mode to 32-bit mode.
   b) Initializes the early platform as needed.
   c) Finds FSP-T and calls the TempRamInit() API. SEC also has the option to initialize the temporary memory directly, in which case this step and step 2 are skipped.
2. FSP initializes temporary memory and returns from TempRamInit() API.
3. SEC initializes the stack in temporary memory.
4. SEC calls the entry point for the PEI core inside the Boot Firmware Volume (BFV).
5. PEI core dispatches the PEIM in the BFV provided by the bootloader.
6. Bootloader installs FSPM_ARCH_CONFIG_PPI.
7. One of the PEIM provided by the bootloader installs a EFI_PEI_FIRMWARE_VOLUME_INFO_PPI for each FV contained in FSP-M.
   a) The bootloader must not install the EFI_PEI_FIRMWARE_VOLUME_INFO_PPI(s) for FSP-M until the bootloader is ready for FSP-M to execute.
   b) If FSP-M requires any DynamicEx PCD values, the bootloader must ensure those PCD contain valid data before installing the EFI_PEI_FIRMWARE_VOLUME_INFO_PPI(s) for FSP-M.
8. PEI core will encounter a second PEI core in FSP-M. Because it is not a PEIM, the dispatcher will skip it. PEI core will proceed to dispatch the PEIM in FSP-M.
9. The boot flow proceeds the same as step 9 in the primary boot flow from here forwards.
8 Intel® FSP API Mode Interface

8.1 Entry-Point Invocation Environment

There are some requirements regarding the operating environment for Intel® FSP execution. The bootloader is responsible to set up this operating environment before calling the Intel® FSP API.

These conditions have to be met before calling any entry point (otherwise, the behavior is not determined). These conditions include:

- The system is in flat 32-bit mode.
- Both the code and data selectors should have full 4GB access range.
- Interrupts should be turned off.
- The FSP API should be called only by the system BSP, unless otherwise noted.
- Sufficient stack space should be available for the FSP API function to execute. Consult the Integration Guide for platform specific stack space requirements.

Other requirements needed by individual FSP API will be covered in the respective sections.

8.2 Data Structure Convention

All data structure definitions should be packed using compiler provided directives such as #pragma pack(1) to avoid alignment mismatch between the FSP and the bootloader.

8.3 Entry-Point Calling Convention

All Intel® FSP API defined in the FSP_INFO_HEADER are 32-bit only. The FSP API interface is similar to the default C __cdecl convention. Like the default C __cdecl convention, with the FSP API interface:

- All parameters are pushed onto the stack in right-to-left order before the API is called.
- The calling function needs to clean the stack up after the API returns.
- The return value is returned in the EAX register. All the other registers including floating point registers are preserved, except as noted in the individual API descriptions below or in Integration Guide.

8.4 Return Status Code

All FSP API return a status code to indicate the API execution result. These return status codes are defined in Section 12.2.1 Appendix A – EFI_STATUS.
Sometimes for an initialization to take effect, a reset may be required. The FSP API may return a status code indicating that a reset is required as documented in 12.2.2 OEM Status code.

When an FSP API returns one of the FSP_STATUS_RESET_REQUIRED code, the bootloader can perform any required housekeeping tasks and issue the reset.

8.5 TempRamInit API

This FSP API is called after coming out of reset and typically performs the following functions - loads the microcode update, enables code caching for a region specified by the bootloader and sets up a temporary memory area to be used prior to main memory being initialized.

The TempRamInit() API should be called using the same entry point calling convention described in the previous section. However platform limitations like unavailability of a stack may require steps as mentioned below.

A hardcoded stack must be set up with the following values:
1. The return address where the TempRamInit() API returns control.
2. A pointer to the input parameter structure for this API.

The ESP register must be initialized to point to this hardcoded stack.

Since the stack may not be writeable, this API cannot be called using the “call” instruction, but needs to be jumped to directly.

The TempRamInit() API preserves the following general purpose registers EBX, EDI, ESI, EBP and the following floating point registers MM0, MM1. The bootloader can use these registers to save data across the TempRamInit() API call. Refer to Integration Guide for other register usage.

Calling this API may be optional. Refer to the Integration Guide for any prerequisites before directly calling FspMemoryInit() API.

If the bootloader uses this API, then it should be called only once after the system comes out the reset, and it must be called before any other FSP API.
8.5.1 Prototype

typedef EFI_STATUS (EFIAPI *FSP_TEMP_RAM_INIT) (
    IN VOID       *FsptUpdDataPtr
);

8.5.2 Parameters

*FsptUpdDataPtr Pointer to the FSPT_UPD data structure. If NULL, FSP will use the defaults from FSP-T component. Refer to the Integration Guide for the structure definition.

8.5.3 Return Values

If this function is successful, the FSP initializes the ECX and EDX registers to point to a temporary but writeable memory range available to the bootloader. Register ECX points to the start of this temporary memory range and EDX points to the end of the range [ECX, EDX], where ECX is inclusive and EDX is exclusive in the range. The bootloader is free to use the whole range described. Typically, the bootloader can reload the ESP register to point to the end of this returned range so that it can be used as a standard stack.

Table 5. Return Values - TempRamInit() API

<table>
<thead>
<tr>
<th>Code</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EFI_SUCCESS</td>
<td>Temporary RAM was initialized successfully.</td>
</tr>
<tr>
<td>EFI_INVALID_PARAMETER</td>
<td>Input parameters are invalid.</td>
</tr>
<tr>
<td>EFI_UNSUPPORTED</td>
<td>The FSP calling conditions were not met.</td>
</tr>
<tr>
<td>EFI_DEVICE_ERROR</td>
<td>Temp RAM initialization failed.</td>
</tr>
</tbody>
</table>

8.5.4 Description

After the bootloader completes its initial steps, it finds the address of the FSP_INFO_HEADER and then from the FSP_INFO_HEADER finds the offset of the TempRamInit() API. It then converts the offset to an absolute address by adding the base of the FSP component and invokes the TempRamInit() API.

The temporary memory range returned by this API is intended to be primarily used by the bootloader as a stack. After this stack is available, the bootloader can switch to using C functions. This temporary stack should be used to do only the minimal initialization that needs to be done before memory can be initialized by the next call into the FSP.

Refer to the Integration Guide for details on FSPT_UPD parameters.
8.6 **FspMemoryInit API**

This FSP API initializes the system memory. This FSP API accepts a pointer to a data structure that will be platform-dependent and defined for each FSP binary.

`FspMemoryInit()` API initializes the memory subsystem, initializes the pointer to the HobListPtr, and returns to the bootloader from where it was called. Since the system memory has been initialized in this API, the bootloader must migrate it's stack and data from temporary memory to system memory after this API.

8.6.1 **Prototype**

```c
typedef
EFI_STATUS
(EIFIAPI *FSP_MEMOY_INIT) (
    IN VOID *FspmUpdDataPtr
    OUT VOID **HobListPtr;
);
```

8.6.2 **Parameters**

<table>
<thead>
<tr>
<th><code>FspmUpdDataPtr</code></th>
<th>Pointer to the FSPM_UPD data structure. If NULL, FSP will use the default from FSP-M component. Refer to the Integration Guide for structure definition.</th>
</tr>
</thead>
<tbody>
<tr>
<td><code>HobListPtr</code></td>
<td>Pointer to receive the address of the HOB list as defined in the Section 12.7 - Appendix A – Data Structures</td>
</tr>
</tbody>
</table>

8.6.3 **Return Values**

The `FspMemoryInit()` API will preserve all the general purpose registers except `EAX`. The return status will be passed back through the `EAX` register.

**Table 6. Return Values - FspMemoryInit() API**

<table>
<thead>
<tr>
<th>Return Value</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EFI_SUCCESS</td>
<td>FSP execution environment was initialized successfully.</td>
</tr>
<tr>
<td>EFI_INVALID_PARAMETER</td>
<td>Input parameters are invalid.</td>
</tr>
<tr>
<td>EFI_UNSUPPORTED</td>
<td>The FSP calling conditions were not met.</td>
</tr>
<tr>
<td>EFI_DEVICE_ERROR</td>
<td>FSP memory initialization failed.</td>
</tr>
<tr>
<td>EFI_OUT_OF_RESOURCES</td>
<td>Stack range requested by FSP is not met.</td>
</tr>
<tr>
<td>FSP_STATUS_RESET_REQUIRED_*</td>
<td>A reset is required. These status codes will not be returned during S3. See section 12.2.2 for details.</td>
</tr>
</tbody>
</table>
8.6.4 Description

When `FspMemoryInit()` API is called, the FSP requires a stack available for its use. Before calling the `FspMemoryInit()` API, the bootloader should setup a stack of required size as mentioned in Integration Guide and initialize the `FSPM_ARCH_UPD.StackBase` and `FSPM_ARCH_UPD.StackSize` parameters. FSP consumes this stack region only inside this API.

A set of parameters that the FSP may need to initialize memory under special circumstances, such as during an S3 resume or during fast boot mode, are returned by the FSP to the bootloader during a normal boot. The bootloader is expected to store these parameters in a non-volatile memory such as SPI flash and return a pointer to this structure through `FSPM_ARCH_UPD.NvsBufferPtr` when it is requesting the FSP to initialize the silicon under these special circumstances. Refer to section 10.2 `FSP_NON_VOLATILE_STORAGE_HOB` for the details on how to get the returned NVS data from FSP.

This API should be called only once before system memory is initialized. This API will produce a HOB list and update the `HobListPtr` output parameter. The HOB list will contain a number of Memory Resource Descriptor HOB which the bootloader can use to understand the system memory map. The bootloader should not expect a complete HOB list after the FSP returns from this API. It is recommended for the bootloader to save this `HobListPtr` returned from this API and parse the full HOB list after the `FspSiliconInit()` API.

When this API returns, the bootloader data and stack are still in temporary memory. It is the responsibility of the bootloader to

- Migrate any data from temporary memory to system memory
- Setup a new bootloader stack in system memory

If an initialization step requires a reset to take effect, the `FspMemoryInit()` API will return one of the `FSP_STATUS_RESET_REQUIRED` status as described in section 8.4. This API will not request a reset during S3 resume flow.
8.7 TempRamExit API

This FSP API is called after FspMemoryInit() API. This FSP API tears down the temporary memory set up by TempRamInit() API. This FSP API accepts a pointer to a data structure that will be platform dependent and defined for each FSP binary.

TempRamExit() API provides bootloader an opportunity to get control after system memory is available and before the temporary memory is torn down.

This API is an optional API, refer to Integration Guide for prerequisites before directly calling FspSiliconInit() API.

8.7.1 Prototype

typedef
EFI_STATUS
(EIFIAPI *FSP_TEMP_RAM_EXIT) (  
    IN VOID *TempRamExitParamPtr
);

8.7.2 Parameters

TempRamExitParamPtr Pointer to the TempRamExit parameters structure. This structure is normally defined in the Integration Guide. If it is not defined in the Integration Guide, pass NULL.

8.7.3 Return Values

The TempRamExit() API will preserve all the general purpose registers except EAX. The return status will be passed back through the EAX register.

Table 7. Return Values - TempRamExit() API

<table>
<thead>
<tr>
<th>Return Code</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EFI_SUCCESS</td>
<td>FSP execution environment was initialized successfully.</td>
</tr>
<tr>
<td>EFI_INVALID_PARAMETER</td>
<td>Input parameters are invalid.</td>
</tr>
<tr>
<td>EFI_UNSUPPORTED</td>
<td>The FSP calling conditions were not met.</td>
</tr>
<tr>
<td>EFI_DEVICE_ERROR</td>
<td>Temporary memory exit.</td>
</tr>
</tbody>
</table>
8.7.4 Description

This API should be called only once after the FspMemoryInit() API and before FspSiliconInit() API.

This API tears down the temporary memory area set up in the cache and returns the cache to normal mode of operation. After the cache is returned to normal mode of operation, any data that was in the temporary memory is destroyed. It is therefore expected that the bootloader migrate any bootloader specific data that it might have had in the temporary memory area and also set up a stack in the system memory before calling TempRamExit() API.

After the TempRamExit() API returns, the bootloader is expected to set up the BSP MTRRs to enable caching. The bootloader can collect the system memory map information by parsing the HOB data structures and use this to set up the MTRR and enable caching.

8.8 FspSiliconInit API

This FSP API initializes the processor and the chipset including the IO controllers in the chipset to enable normal operation of these devices.

This API should be called only once after the system memory has been initialized, data from temporary memory migrated to system memory and cache configuration has been initialized.

8.8.1 Prototype

typedef EFI_STATUS (EFI_API *FSP_SILICON_INIT) (IN VOID *FspUpdDataPtr);

8.8.2 Parameters

| FspUpdDataPtr | Pointer to the FSPS_UPD data structure. If NULL, FSP will use the default parameters. Refer to the Integration Guide for structure definition. |
8.8.3 Return Values

The FspSiliconInit API will preserve all the general purpose registers except EAX. The return status will be passed back through the EAX register.

<table>
<thead>
<tr>
<th>Code</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EFI_SUCCESS</td>
<td>FSP execution environment was initialized successfully.</td>
</tr>
<tr>
<td>EFI_INVALID_PARAMETER</td>
<td>Input parameters are invalid.</td>
</tr>
<tr>
<td>EFI_UNSUPPORTED</td>
<td>The FSP calling conditions were not met.</td>
</tr>
<tr>
<td>EFI_DEVICE_ERROR</td>
<td>FSP silicon initialization failed.</td>
</tr>
<tr>
<td>FSP_STATUS_RESET_REQUIRED_*</td>
<td>A reset is required. These status codes will not be returned during S3.</td>
</tr>
</tbody>
</table>

8.8.4 Description

This API should be called only once after the FspMemoryInit() API (if the bootloader is not using TempRamExit() API) or the TempRamExit() API.

This FSP API accepts a pointer to a data structure that will be platform dependent and defined for each FSP binary. This will be documented in the Integration Guide.

This API adds HOBs to the HobListPtr to pass more information to the bootloader. To obtain the additional information, the bootloader must parse the HOB list again after the FSP returns from this API.

If an initialization step requires a reset to take effect, the FspSiliconInit() API will return an FSP_STATUS_RESET_REQUIRED as described in section 8.4. This API will not request a reset during S3 resume flow.

8.9 NotifyPhase API

This FSP API is used to notify the FSP about the different phases in the boot process. This allows the FSP to take appropriate actions as needed during different initialization phases. The phases will be platform dependent and will be documented with the FSP release. The current FSP specification supports three notify phases:

- Post PCI enumeration
- Ready To Boot
- End Of Firmware
8.9.1 Prototype

typedef

EFI_STATUS
(EFIAPI *FSP_NOTIFY_PHASE) (  
    IN NOTIFY_PHASE_PARAMS *NotifyPhaseParamPtr
);

8.9.2 Parameters

NotifyPhaseParamPtr Address pointer to the NOTIFY_PHASE_PARAMS

8.9.3 Related Definitions

typedef enum {
    EnumInitPhaseAfterPciEnumeration = 0x20,
    EnumInitPhaseReadyToBoot = 0x40,
    EnumInitPhaseEndOfFirmware = 0xF0
} FSP_INIT_PHASE;

typedef struct {
    FSP_INIT_PHASE  Phase;
} NOTIFY_PHASE_PARAMS;

EnumInitPhaseAfterPciEnumeration
This stage is notified when the bootloader completes the PCI enumeration and the resource allocation for the PCI devices is complete.

EnumInitPhaseReadyToBoot
This stage is notified just before the bootloader hand-off to the OS loader.

EnumInitPhaseEndOfFirmware
This stage is notified just before the firmware/Preboot environment transfers management of all system resources to the OS or next level execution environment.

When booting to non-UEFI OS, this stage is notified immediately after the EnumInitPhaseReadyToBoot. When booting to UEFI OS this stage is notified at ExitBootServices callback from OS.
8.9.4 Return Values

The NotifyPhase() API will preserve all the general purpose registers except EAX. The return status will be passed back through the EAX register.

Table 9. Return Values – NotifyPhase() API

<table>
<thead>
<tr>
<th>Return Value</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EFI_SUCCESS</td>
<td>The notification was handled successfully.</td>
</tr>
<tr>
<td>EFI_UNSUPPORTED</td>
<td>The notification was not called in the proper order.</td>
</tr>
<tr>
<td>EFI_INVALID_PARAMETER</td>
<td>The notification code is invalid.</td>
</tr>
<tr>
<td>FSP_STATUS_RESET_REQUIRED_*</td>
<td>A reset is required. These status codes will not be returned during S3.</td>
</tr>
</tbody>
</table>

8.9.5 Description

**EnumInitPhaseAfterPciEnumeration**

FSP will use this notification to do some specific initialization for processor and chipset that requires PCI resource assignments to have been completed.

This API must be called before executing 3rd party code, including PCI Option ROM, for secure design reasons.

On S3 resume path this API must be called before the bootloader hand-off to the OS resume vector.

**EnumInitPhaseReadyToBoot**

FSP will perform required configuration by the BWG / BIOS Specification when it is notified that the bootloader is ready to transfer control to the OS loader.

On S3 resume path this API must be called after EnumInitPhaseAfterPciEnumeration notification and before the bootloader hand-off to the OS resume vector.

**EnumInitPhaseEndOfFirmware**

FSP can use this notification to perform some handoff of the system resources before transferring control to the OS.

When booting to non-UEFI OS this stage is notified immediately after the EnumInitPhaseReadyToBoot. When booting to UEFI OS this stage is notified at ExitBootServices callback from OS.

On the S3 resume path this API must be called after EnumInitPhaseReadyToBoot notification and before the bootloader hand-off to the OS resume vector.

After this phase, the whole FSP flow is considered to be complete and the results of any further FSP API calls are undefined.
If an initialization step requires a reset to take effect, the \texttt{NotifyPhase()} API will return an \texttt{FSP\_STATUS\_RESET\_REQUIRED} as described in section 8.4. This API will not request a reset during S3 resume flow.
Dispatch mode is an optional boot flow intended to enable FSP to integrate well in to UEFI bootloader implementations. The `FSP_INFO_HEADER` indicates if an FSP implements dispatch mode, see Section 5.1.1 for further details.

### 9.1 Dispatch Mode Design

**Figure 6: Dispatch Mode Design**

Dispatch mode is intended to enable a boot flow that is as close to a standard UEFI boot flow as possible. FSP dispatch mode fully conforms to the *PI Specification* and assumes the boot loader will follow the standard four phase PI boot flow progressing from SEC phase, to PEI phase, to DXE phase, to BDS phase. It is recommended that the reader have knowledge of the contents of the *PI Specification* before continuing.

In dispatch mode, FSP-T, FSP-M, and FSP-S are containers that expose firmware volumes (FVs) directly to the bootloader. The PEIMs in these FVs are executed directly in the context of the PEI environment provided by the bootloader. FSP-T, FSP-M, and FSP-S could contain one or multiple FVs. The exact number of FVs contained in FSP-T, FSP-M, and FSP-S will be described in the *Integration Guide*. In dispatch mode, the PPI database, PCD database, and HOB list are shared between the bootloader and the FSP.

UPDs are not needed to provide a mechanism to pass configuration data from the bootloader to the FSP. Instead, configuration data is communicated to the FSP using PCDs and PPIs. These mechanisms are native to bootloader implementations conforming to the *PI Specification* and constitute a more natural method of supplying configuration data to the FSP. These PCDs and PPIs are platform specific. The *FSP*
Distribution Package will contain source code definitions of the configuration data structures consumed by the FSP. The configuration data structures will also be described by the Integration Guide.

The bootloader must provide the PCD database implementation. Any dynamic PCDs consumed by the FSP must be included in the PCD database provided by the bootloader. The FSP Distribution Package will contain a DSC file which defines all PCDs used by the FSP. The recommended method of including these PCDs is to use the
!include directive in the bootloader’s top-level platform DSC file. Because the FSP is a pre-compiled binary, all dynamic PCDs consumed by the FSP must be of the DynamicEx type. Refer to MdeModulePkg/Universal/PCD/Pei/Pcd.inf for more details on platform token numbers. In addition to the DSC file included in the FSP Distribution Package, the Integration Guide will also list the PCDs (along with TokenSpace GUID and TokenNumber) consumed by the FSP.

In dispatch mode, the NotifyPhase() API is not used. Instead, FSP-S contains DXE drivers that implement the native callbacks on equivalent events for each of the NotifyPhase() invocations. The inclusion of DXE drivers allows dispatch mode to provide capabilities that would not be possible in API mode.

9.2 PEI Phase Requirements

PEIMs contained in FSP firmware volumes are intended to be executed within the processor context and calling conventions defined by the PI Specification, Volume 1 for either the IA-32 or x64 platforms. The exact target platform will be specified in the Integration Guide.

PEIMs contained in the FSP shall use a subset of the API provided by the PEI Foundation. Specifically, PEIMs contained in FSP firmware volumes shall not use the following architecturally defined PPIs:

- EFI_PEI_READ_ONLY_VARIABLE2_PPI

9.3 DXE and BDS Phase Requirements

DXE drivers contained in FSP firmware volumes are intended to be executed within the processor context and calling conventions defined by the PI Specification, Volume 2 for x64 platforms.

DXE drivers contained in the FSP shall use a subset of the API provided by the DXE Foundation. Specifically, DXE drivers contained in FSP firmware volumes shall not use the following UEFI services:

- ExitBootServices()
- SetWatchdogTimer()
- GetVariable()
- GetNextVariableName()
- SetVariable()
- QueryVariableInfo()
- SetTime()
- SetWakeupTime()
• UpdateCapsule()
• QueryCapsuleCapabilities()

In addition, FSP may use the following *PI Specification* defined events during DXE phase:

1. **EFI_END_OF_DXE_EVENT_GROUP_GUID** – The *PI Specification* requires the bootloader to signal this event prior to invoking any UEFI drivers or applications that are not from the platform manufacturer, or connecting consoles.

2. **EFI_PCI_ENUMERATION_PROTOCOL** – The *PI Specification* requires the bootloader to install this protocol after PCI enumeration is complete.

3. **EFI_EVENT_GROUP_READY_TO_BOOT** – The *PI Specification* requires the bootloader to signal this event when it is about to load and execute a boot option.

4. Create an event to be notified when ExitBootServices() is invoked using **EVT_SIGNAL_EXIT_BOOT_SERVICES**.

DXE drivers may use other events for platform specific use cases. Any additional events beyond those described above will be documented in the *Integration Guide*.

### 9.4 Dispatch Mode API

FSP dispatch mode fully conforms to the *PI Specification*. Accordingly, dispatch mode does not require many FSP specific API definitions since the *PI Specification* already defines most API. This section therefore only describes FSP specific extensions to the *PI Specification*. Most FSP API will be platform specific and therefore documented in the *Integration Guide*.

#### 9.4.1 TempRamInit API

The *PI Specification* defines a code module format for PEI and DXE (PEIMs, and DXE Drivers respectively.) However, the *PI Specification* does not define a module format for SEC phase. Temporary RAM must be initialized during the SEC phase. Therefore, in dispatch mode FSP-T uses the same API defined in Section 8.5 to provide TempRamInit() to the bootloader SEC implementation.

#### 9.4.2 EFI PEI Core Firmware Volume Location PPI

If the boot flow described in section 7.2.2 is followed, the PEI Foundation does not reside in the Boot Firmware Volume (BFV). In compliance with the *PI Specification v1.7*, SEC must pass the **EFI_PEI_CORE_FV_LOCATION_PPI** as a part of the PPI list provided to the PEI Foundation Entry Point. Please see section 6.3.9 of the *PI Specification v1.7 Volume 1* for more details on this PPI. If the alternate boot flow described in section 7.2.3 is followed, then the PEI Foundation resides in the BFV. Accordingly, this PPI should not be produced.
9.4.3  **FSP Temporary RAM Exit PPI**

**FSP_TEMP_RAM_EXIT_PPI**

9.4.3.1 **Summary**

Tears down the temporary memory set up by TempRamInit() API.

9.4.3.2 **GUID**

```c
#define FSP_TEMP_RAM_EXIT_GUID \
{0xbc1cfbdb, 0x7e50, 0x42be, \ 
{0xb4, 0x87, 0x22, 0xe0, 0xa9, 
0xb0, 0x52}}
```

9.4.3.3 **Prototype**

```c
typedef struct {
    FSP_TEMP_RAM_EXIT   TempRamExit;
} FSP_TEMP_RAM_EXIT_PPI;
```

9.4.3.4 **Parameters**

| TempRamExit | Tears down the temporary memory set up by TempRamInit() API. |

9.4.3.5 **Description**

This PPI provides the equivalent functionality as the TempRamExit() function defined in Section 8.7 to bootloaders that use the FSP in dispatch mode. The TempRamExit() function defined in this PPI tears down the temporary memory set up by TempRamInit() API. Bootloaders that use dispatch mode must not use the TempRamExit() API defined in Section 8.7, they must use this PPI instead.

9.4.4  **FSP_TEMP_RAM_EXIT_PPI.TempRamExit ()**

9.4.4.1 **Summary**

Tears down the temporary memory set up by TempRamInit() API.
9.4.4.2 Prototype

```c
typedef EFI_STATUS
    (EFIAPI *FSP_TEMP_RAM_EXIT) (IN VOID *TempRamExitParamPtr);
```

9.4.4.3 Parameters

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>TempRamExitParamPtr</td>
<td>Pointer to the TempRamExit parameters structure. This structure is normally defined in the Integration Guide. If it is not defined in the Integration Guide, pass NULL.</td>
</tr>
</tbody>
</table>

9.4.4.4 Description

This API is intended to be used by the bootloader's implementation of EFI_PEI_TEMPORARY_RAM_DONE_PPI. This API tears down the temporary memory set up by the TempRamInit() API. This API accepts a pointer to a data structure that will be platform dependent and defined for each FSP binary.

The FSP_TEMP_RAM_EXIT_PPI->TempRamExit() API provides the bootloader an opportunity to get control after system memory is available and before the temporary memory is torn down. Therefore, is is the bootloader's responsibility to call FSP_TEMP_RAM_EXIT_PPI->TempRamExit() when ready.

This API is an optional API, refer to the Integration Guide for prerequisites before installing the EFI_PEI_FIRMWARE_VOLUME_INFO_PPI instances to begin dispatch of PEIMs in FSP-S firmware volume(s).

**Implementation Note:** The UefiCpuPkg in EDK2 provides a reference implementation of SEC phase. If the bootloader elects to use this, at time of writing the UefiCpuPkg implementation of SEC core produces the EFI_PEI_TEMPORARY_RAM_DONE_PPI. The TemporaryRamDone() implementation in SEC core will call SecPlatformDisableTemporaryMemory(), this function is implemented by the bootloader. The bootloader implementation of this function would then locate FSP_TEMP_RAM_EXIT_PPI and call TempRamExit() when ready.

9.4.4.5 Return Values

<table>
<thead>
<tr>
<th>Return Value</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EFI_SUCCESS</td>
<td>FSP execution environment was initialized successfully.</td>
</tr>
<tr>
<td>EFI_INVALID_PARAMETER</td>
<td>Input parameters are invalid.</td>
</tr>
<tr>
<td>EFI_UNSUPPORTED</td>
<td>The FSP calling conditions were not met.</td>
</tr>
<tr>
<td>EFI_DEVICE_ERROR</td>
<td>Temporary memory exit.</td>
</tr>
</tbody>
</table>
9.4.5 **FSP-M Architectural Configuration PPI**

**FSPM_ARCH_CONFIG_PPI**

9.4.5.1 **Summary**

Architectural configuration data for FSP-M.

9.4.5.2 **GUID**

```c
#define FSPM_ARCH_CONFIG_GUID \
{0x824d5a3a, 0xaf92, 0x4c0c, \ 
{0x9f, 0x19, 0x19, 0x52, 0x6d, 0xca, 0x4a, 0xbb}}
```

9.4.5.3 **Prototype**

```c
typedef struct {
    UINT8                      Revision;
    UINT8                      Reserved[3]
    VOID                       *NvsBufferPtr;
    UINT32                     BootLoaderTolumSize;
    UINT8                      Reserved1[4];
} FSPM_ARCH_CONFIG_PPI;
```

9.4.5.4 **Parameters**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Revision</td>
<td>Revision of the structure is 1 for this version of the specification.</td>
</tr>
<tr>
<td>NvsBufferPtr</td>
<td>Pointer to the non-volatile storage (NVS) data buffer. If it is NULL it indicates the NVS data is not available. Refer to Section 10.2 for more details.</td>
</tr>
<tr>
<td>BootloaderTolumSize</td>
<td>Size of memory to be reserved by FSP below &quot;top of low usable memory&quot; for bootloader usage. Refer to Section 10.3 for more details.</td>
</tr>
</tbody>
</table>

9.4.5.5 **Description**

This PPI contains architectural configuration data that is needed by PEIMs in FSP-M and/or FSP-S. It is the responsibility of the bootloader to install this PPI. The bootloader must be able to provide these data within the pre-memory PEI timeframe. In adherence with the weak ordering requirement for PEIMs, any PEIM contained in FSP that uses this PPI shall either include this PPI in its DEPEX or shall register a callback using (*PeiServices)->NotifyPpi () and refrain from accessing these data until the callback is invoked by the PEI Foundation.

As a performance optimization, it is recommended (but not required) that the bootloader install this PPI before installing **EFI_PEI_FIRMWARE_VOLUME_INFO_PPI** instances for the firmware volume(s) contained in FSP-M. This will reduce the number of times the PEI Dispatcher will need to loop in order to complete PEI phase.
9.4.6  FSP Error Information

FSP_ERROR_INFO

9.4.6.1 Summary

Notifies the bootloader of a fatal error occurring during the execution of the FSP.

9.4.6.2 GUID

```c
#define STATUS_CODE_DATA_TYPE_FSP_ERROR_GUID \ 
 {0x611e6a88, 0xadB7, 0x4301, \ 
  {0x93, 0xff, 0xe4, 0x73, 0x04, 0xb4, 0x3d, 0xa6}}
```

9.4.6.3 Prototype

```c
typedef struct {
    EFI_STATUS_CODE_DATA    DataHeader;
    EFI_GUID                ErrorType;
    EFI_STATUS              Status;
} FSP_ERROR_INFO;
```

9.4.6.4 Parameters

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>DataHeader</td>
<td>The data header identifying the data. DataHeader.HeaderSize shall be sizeof (EFI_STATUS_CODE_DATA). DataHeader.Size shall be sizeof (FSP_ERROR_INFO) - HeaderSize. Finally, DataHeader.Type shall be STATUS_CODE_DATA_TYPE_FSP_ERROR_GUID.</td>
</tr>
<tr>
<td>ErrorType</td>
<td>A GUID identifying the nature of the fatal error. This GUID is platform specific. A listing of all possible GUIDs shall be provided by the Integration Guide.</td>
</tr>
<tr>
<td>Status</td>
<td>A code describing the error encountered. Please see section 12.2 for a listing of possible error codes.</td>
</tr>
</tbody>
</table>

9.4.6.5 Description

In the case of a fatal error occurring during the execution of the FSP, it may not be possible for the FSP to continue. If a fatal error that prevents the successful completion of the FSP occurs, the FSP may use FSP_ERROR_INFO to report this error to the bootloader. During PEI phase, (*PeiServices)-> ReportStatusCode () shall be used to transmit this error notification to the bootloader. During DXE phase, EFI_STATUS_CODE_PROTOCOL.ReportStatusCode () shall be used to transmit this error notification to the bootloader. The bootloader must ensure that ReportStatusCode () services are available before FSP-M begins execution. When the FSP calls ReportStatusCode (), the Type parameter’s EFI_STATUS_CODE_TYPE_MASK must be EFI_ERROR_CODE with the EFI_STATUS_CODE_SEVERITY_MASK >= EFI_ERROR_UNRECOVERED. The
Value and Instance parameters must be 0. The CallerId parameter should be a GUID that identifies the PEIM or DXE driver which was executing at the time of the error.

The bootloader must register a listener for this status code. This listener should check if `DataHeader.Type == STATUS_CODE_DATA_TYPE_FSP_ERROR_GUID` to detect an `FSP_ERROR_INFO` notification. If an `FSP_ERROR_INFO` notification is encountered, the bootloader should assume that normal operation is no longer possible. In debug scenarios, this notification should be considered an ASSERT. In a production environment the most simple and least effective method of handling this error is a CPU dead loop, which effectively causes a bricked system. A more robust and recommended solution would be to initiate a firmware recovery. If the bootloader does not handle this notification, the PEIM or DXE driver that called `ReportStatusCode()` will immediately return back to the dispatcher with an `EFI_STATUS` return code matching the `Status` field in `FSP_ERROR_INFO`. Continuing to dispatch FSP PEIMs or DXE Drivers after this will result in undefined behavior. The bootloader should initiate recovery flows instead of continuing with normal dispatch.

### 9.4.7 FSP Debug Messages

Intel® FSP may optionally include the capability of generating log messages to aid in the debugging of firmware issues. When technically feasible, these log messages will be broadcast to the bootloader from the FSP by calling `(*PeiServices)->ReportStatusCode()` in PEI phase or `EFI_STATUS_CODE_PROTOCOL.ReportStatusCode()` in DXE phase. `ReportStatusCode()` will be called with the Type parameter’s `EFI_STATUS_CODE_TYPE_MASK` set to `EFI_DEBUG_CODE` and the Data parameter containing a `EFI_STATUS_CODE_STRING_DATA` payload. Please see section 6.6.2 of the *PI Specification v1.7 Volume 3* for details on `EFI_STATUS_CODE_STRING_DATA`. The FSP shall only pass a `EFI_STRING_TYPE` of `EfiStringAscii` for the purposes of debug log messages. The Instance parameter shall contain the ErrorLevel, please see section 12.9 for details. The bootloader may register a listener for these status codes if debug log messages are of interest.

`ReportStatusCode()` is not supported in API mode.

It should be noted that the strings for these log messages increase the binary size of the FSP considerably. Accordingly FSP binaries intended for production use are unlikely include debug log messages.
The Intel® FSP builds a series of data structures called the Hand Off Blocks (HOBs). These data structures conform to the HOB format as described in the Platform Initialization (PI) Specification - Volume 3: Shared Architectural Elements specification as referenced in Section 1.3 Related Documentation. The user of the Intel® FSP binary is strongly encouraged to go through the specification mentioned above to understand the HOB details and create a simple infrastructure to parse the HOB list, because the same infrastructure can be reused with different Intel® FSP across different platforms.

The bootloader developer must decide on how to consume the information passed through the HOB produced by the Intel® FSP. The PI Specification defines a number of HOB and most of this information may not be relevant to a particular bootloader. For example, to generate system memory map, bootloader needs to parse the resource descriptor HOBs produced by FSP-M.

In addition to the PI Specification defined HOB, the FSP produces a number of FSP architecturally defined GUID type HOB. The sections below describes the GUID and the structure of these FSP defined HOB.

Additional platform specific HOB may be defined in the Integration Guide.
10.1 FSP_RESERVED_MEMORY RESOURCE_HOB

The FSP optionally reserves some memory for its internal use and a descriptor for this memory region used by the FSP is passed back through a HOB. This is a generic resource HOB, but the owner field of the HOB identifies the owner as FSP. This FSP reserved memory region must be preserved by the bootloader and must be reported as reserved memory to the OS.

This HOB follows the EFI_HOB_RESOURCE_DESCRIPTOR format with the owner GUID defined as below.

#define FSP_RESERVED_MEMORYRESOURCE_HOB_GUID
{ 0x69a79759, 0x1373, 0x4367, { 0xa6, 0xc4, 0xc7, 0xf5, 0x9e, 0xfd, 0x98, 0x6e } }

This HOB is valid after FspMemoryInit() API.

10.2 FSP_NON_VOLATILE_STORAGE_HOB

The Non-Volatile Storage (NVS) HOB provides a mechanism for FSP to request the bootloader to save the platform configuration data into non-volatile storage so that it can be reused in special cases, such as S3 resume or fast boot.

This HOB follows the EFI_HOB_GUID_TYPE format with the name GUID defined as below:

#define FSP_NON_VOLATILE_STORAGE_HOB_GUID
{ 0x721acf02, 0x4d77, 0x4c2a, { 0xb3, 0xdc, 0x27, 0xb, 0x7b, 0xa9, 0xe4, 0xb0 }

The bootloader needs to parse the HOB list to see if such a GUID HOB exists after memory is initialized. The HOB shall be populated either after returning from FspMemoryInit() in API mode or after all notification call backs for EFI_PEI_PERMANENT_MEMORY_INSTALLED_PPI the have completed in dispatch mode. If it exists, the bootloader should extract the data portion from the HOB structure and then save it into a platform-specific NVS device, such as flash, EEPROM, etc. On the following boot flow the bootloader should load the data block back from the NVS device to temporary memory and populate the buffer pointer into FSPM_ARCH_UPD.NvsBufferPtr field before calling FspMemoryInit() in API mode or FSPM_ARCH_CONFIG_PPI.NvsBufferPtr before installing FSPM_ARCH_CONFIG_PPI in dispatch mode. If the NVS device is memory mapped, the bootloader can initialize the buffer pointer directly to the buffer.

This HOB must be parsed after FspMemoryInit() in API mode or when a PPI notification for EFI_PEI_PERMANENT_MEMORY_INSTALLED_PPI with EFI_PEI_PPI_DESCRIPTOR_NOTIFY_DISPATCH priority is invoked in dispatch mode (EFI_PEI_PPI_DESCRIPTOR_NOTIFY_CALLBACK priority is too early.)

This HOB is produced only when new NVS data is generated. For example, if this HOB is not produced in S3 or fast boot, bootloader should continue to pass the existing NVS data to FSP during next boot.
10.3 FSP_BOOTLOADER_TOLUM_HOB

The FSP can reserve some memory below "top of low usable memory" for bootloader usage. The size of this region is determined by 
FSPM_ARCH_UPD.BootLoaderTolumSize when in API mode or 
FSPM_ARCH_CONFIG_PPI.BootLoaderTolumSize when in dispatch mode. The FSP reserved memory region will be placed below this region.

This HOB will only be published when the BootLoaderTolumSize is valid and non zero.

This HOB follows the EFI_HOB_RESOURCE_DESCRIPTOR format with the owner GUID defined as below:

#define FSP_BOOTLOADER_TOLUM_HOB_GUID \\ 
{ 0x73ff4f56, 0xaa8e, 0x4451, { 0xb3, 0x16, 0x36, 0x35, 0x36, 0x67, 0xad, 0x44 }}

This HOB is valid after FspMemoryInit() in API mode or when a PPI notification for EFI_PEI_PERMANENT_MEMORY_INSTALLED_PPI with EFI_PEI_PPI_DESCRIPTOR_NOTIFY_DISPATCH priority is invoked in dispatch mode (EFI_PEI_PPI_DESCRIPTOR_NOTIFY_CALLBACK priority is too early.)

10.4 EFI_PEI_GRAPHICS_INFO_HOB

If BIT0 (Graphics Support) of the ImageAttribute field in the FSP_INFO_HEADER is set, the FSP includes graphics initialization capabilities. To complete the initialization of the graphics system, FSP may need some platform specific configuration data which would be documented in the Integration Guide.

When graphics capability is included in FSP and enabled as documented in Integration Guide, FSP produces a EFI_PEI_GRAPHICS_INFO_HOB as described in the PI Specification as referenced in Section 1.3 Related Documents, which provides information about the graphics mode and framebuffer.

#define EFI_PEI_GRAPHICS_INFO_HOB_GUID \\ 
{ 0x39f62cce, 0x6825, 0x4669, { 0xbb, 0x56, 0x54, 0x1a, 0xba, 0x75, 0x3a, 0x07 }}

It is to be noted that the FrameBufferAddress address in 
EFI_PEI_GRAPHICS_INFO_HOB will reflect the value assigned by the FSP. A bootloader consuming this HOB should be aware that a generic PCI enumeration logic could reprogram the temporary resources assigned by the FSP and it is the responsibility of the bootloader to update its internal data structures with the new framebuffer address after the enumeration is complete.

This HOB is valid after FspSiliconInit() in API mode or when EFI_PEI_END_OF_PEI_PHASE_PPI is installed in dispatch mode.
10.5 EFI_PEI_GRAPHICS_DEVICE_INFO_HOB

If BIT0 (Graphics Support) of the ImageAttribute field in the FSP_INFO_HEADER is set, the FSP includes graphics initialization capabilities. To complete the initialization of the graphics system, FSP may need some platform specific configuration data which would be documented in the Integration Guide.

When graphics capability is included in FSP and enabled as documented in Integration Guide, FSP produces an EFI_PEI_GRAPHICSDEVICE_INFO_HOB as described in the PI Specification as referenced in Section 1.3 Related Documents, which provides information about the graphics hardware which produces the framebuffer supplied by EFI_PEI_GRAPHICS_INFO_HOB.

#define EFI_PEI_GRAPHICS_DEVICE_INFO_HOB_GUID \
{ 0xe5cb2ac9, 0xd35d, 0x4430, \{ 0x93, 0x6e, 0x1d, 0xe3, 0x32, 0x47, 0x8d, 0xe7 \}}

Together, EFI_PEI_GRAPHICS_INFO_HOB and EFI_PEI_GRAPHICSDEVICE_INFO_HOB provide sufficient information to implement a basic graphics driver.

This HOB is valid after FspSiliconInit() in API mode or when EFI_PEI_END_OF_PEI_PHASE_PPI is installed in dispatch mode.

10.6 FSP_ERROR_INFO_HOB

In the case of an error occurring during the execution of the FSP, the FSP may optionally produce an FSP_ERROR_INFO_HOB which describes the error in more detail. This HOB is only produced in API mode. In dispatch mode, ReportStatusCode() is used as described in section 9.4.6.

#define FSP_ERROR_INFO_HOB_GUID \ 
{0x611e6a88, 0xabd7, 0x4301, \ 
{0x93, 0xff, 0xe4, 0x73, 0x04, 0xb4, 0x3d, 0xa6}}

typedef struct {
    EFI_HOB_GUID_TYPE GuidHob;
    EFI_STATUS_CODE_TYPE Type;
    EFI_STATUS_CODE_VALUE Value;
    UINT32 Instance;
    EFI_GUID CallerId;
    EFI_GUID ErrorType;
    UINT32 Status;
} FSP_ERROR_INFO_HOB;
| **GuidHob** | The GUID HOB header identifying the data. *GuidHob.Name* shall be `FSP_ERROR_INFO_HOB_GUID`. |
| **Type** | A `ReportStatusCode()` type identifier. The Type’s `EFI_STATUS_CODE_TYPE_MASK` must be `EFI_ERROR_CODE` with the `EFI_STATUS_CODE_SEVERITY_MASK` `<= EFI_ERROR_UNRECOVERED`. See Section 6 of the PI Specification v1.7 Volume 3. |
| **Value** | A `ReportStatusCode()` Value. Used to determine status code class and sub-class, see Section 6 of the PI Specification v1.7 Volume 3. This field shall be set to zero (0). |
| **Instance** | A `ReportStatusCode()` Instance number. See Section 6 of the PI Specification v1.7 Volume 3. This field shall be set to zero (0). |
| **CallerId** | An optional GUID which may be used to identify which internal component of the FSP was executing at the time of the error. If the FSP does not implement this CallerId shall be zero (0). |
| **ErrorType** | A GUID identifying the nature of the fatal error. This GUID is platform specific. A listing of all possible GUIDs shall be provided by the Integration Guide. |
| **Status** | A code describing the error encountered. Please see section 12.2 for a listing of possible error codes. |

If an `FSP_ERROR_INFO_HOB` is found, the bootloader should assume that normal operation is no longer possible. In debug scenarios, this notification should be considered an ASSERT. In a production environment the most simple and least effective method of handling this error is a CPU dead loop, which effectively causes a bricked system. A more robust and recommended solution would be to initiate a firmware recovery. If a `FSP_ERROR_INFO_HOB` is produced after an FSP API call, the bootloader should not call any of the subsequent FSP APIs (if any) and should instead initiate recovery flows.
11 Other Host BootLoader Considerations

11.1 ACPI

ACPI is an independent component of the bootloader, and is not provided by the FSP in API mode. In dispatch mode, DXE drivers included with the FSP may optionally use the EFI_ACPI_TABLE_PROTOCOL to install ACPI tables.

11.2 Bus Enumeration

FSP will initialize the processor and the chipset to a state that all bus topology can be discovered by the host bootloader. However, it is the responsibility of the bootloader to enumerate the bus topology.

11.3 Security

FSP will follow the BWG / BIOS Specification to lock the necessary silicon specific registers. However, platform features like measured boot, verified, and authenticated boot are responsibilities of the bootloader.
The declarations/definitions provided here were derived from the EDK2 source available for download at https://github.com/tianocore/edk2

## 12.1 BOOT_MODE

### 12.1.1 PiBootMode.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Pl/PiBootMode.h

```c
#define BOOT_WITH_FULL_CONFIGURATION           0x00
#define BOOT_WITH_MINIMAL_CONFIGURATION        0x01
#define BOOT_ASSUME_NO_CONFIGURATION_CHANGES  0x02
#define BOOT_ON_S4_RESUME                     0x05
#define BOOT_ON_S3_RESUME                     0x11
#define BOOT_ON_FLASH_UPDATE                  0x12
#define BOOT_IN_RECOVERY_MODE                 0x20
```
12.2 **EFI_STATUS**

12.2.1 **UefiBaseType.h**

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Uefi/UefiBaseType.h

```c
#define EFI_SUCCESS 0x00000000
#define EFI_INVALID_PARAMETER 0x80000002
#define EFI_UNSUPPORTED 0x80000003
#define EFI_NOT_READY 0x80000006
#define EFI_DEVICE_ERROR 0x80000007
#define EFI_OUT_OF_RESOURCES 0x80000009
#define EFI_VOLUME_CORRUPTED 0x8000000A
#define EFI_NOT_FOUND 0x8000000E
#define EFI_TIMEOUT 0x80000012
#define EFI_ABORTED 0x80000015
#define EFI_INCOMPATIBLE_VERSION 0x80000019
#define EFI_SECURITY_VIOLATION 0x8000001A
#define EFI_CRC_ERROR 0x8000001B
```

```c
typedef UINT64 EFI_PHYSICAL_ADDRESS;
```

12.2.2 **OEM Status Code**

The range of status code that have the highest bit clear and the next to highest bit set are reserved for use by OEMs.

The FSP will use the following status to indicate that an API is requesting that a reset is required.
Appendix A – Data Structures

#define FSP_STATUS_RESET_REQUIRED_COLD 0x40000001
#define FSP_STATUS_RESET_REQUIRED_WARM 0x40000002
#define FSP_STATUS_RESET_REQUIRED_3 0x40000003
#define FSP_STATUS_RESET_REQUIRED_4 0x40000004
#define FSP_STATUS_RESET_REQUIRED_5 0x40000005
#define FSP_STATUS_RESET_REQUIRED_6 0x40000006
#define FSP_STATUS_RESET_REQUIRED_7 0x40000007
#define FSP_STATUS_RESET_REQUIRED_8 0x40000008
12.3 EFI_PEI_GRAPHICS_INFO_HOB

12.3.1 GraphicsInfoHob.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Guid/GraphicsInfoHob.h

typedef struct {
    EFI_PHYSICAL_ADDRESS FrameBufferBase;
    UINT32 FrameBufferSize;
    EFI_GRAPHICS_OUTPUT_MODE_INFORMATION GraphicsMode;
} EFI_PEI_GRAPHICS_INFO_HOB;

12.4 EFI_PEI_GRAPHICS_DEVICE_INFO_HOB

12.4.1 GraphicsInfoHob.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Guid/GraphicsInfoHob.h

typedef struct {
    UINT16 VendorId;
    UINT16 DeviceId;
    UINT16 SubsystemVendorId;
    UINT16 SubsystemId;
    UINT8 RevisionId;
    UINT8 BarIndex;
} EFI_PEI_GRAPHICS_DEVICE_INFO_HOB;

12.5 EFI_GUID

12.5.1 Base.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Base.h

typedef struct {
    UINT32 Data1;
    UINT16 Data2;
    UINT16 Data3;
    UINT8 Data4[8];
} GUID;

12.5.2 UefiBaseType.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Uefi/UefiBaseType.h

typedef GUID EFI_GUID;
12.6 **EFI_MEMORY_TYPE**

12.6.1 **UefiMultiPhase.h**

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Uefi/UefiMultiPhase.h

```c
/// Enumeration of memory types.
typedef enum {
    EfiReservedMemoryType,
    EfiLoaderCode,
    EfiLoaderData,
    EfiBootServicesCode,
    EfiBootServicesData,
    EfiRuntimeServicesCode,
    EfiRuntimeServicesData,
    EfiConventionalMemory,
    EfiUnusableMemory,
    EfiACPIReclaimMemory,
    EfiACPIMemoryNVS,
    EfiMemoryMappedIO,
    EfiMemoryMappedIOPortSpace,
    EfiPalCode,
    EfiPersistentMemory,
    EfiMaxMemoryType
} EFI_MEMORY_TYPE;
```
12.7 Hand Off Block (HOB)

12.7.1 PiHob.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Pl/PiHob.h

typedef UINT32 EFI_RESOURCE_TYPE;
typedef UINT32 EFI_RESOURCE_ATTRIBUTE_TYPE;

    //
    // Value of ResourceType in EFI_HOB_RESOURCE_DESCRIPTOR.
    //
    #define EFI_RESOURCE_SYSTEM_MEMORY 0x00000000
    #define EFI_RESOURCE_MEMORY_MAPPED_IO 0x00000001
    #define EFI_RESOURCE_IO 0x00000002
    #define EFI_RESOURCE_FIRMWARE_DEVICE 0x00000003
    #define EFI_RESOURCE_MEMORY_MAPPED_IO_PORT 0x00000004
    #define EFI_RESOURCE_MEMORY_RESERVED 0x00000005
    #define EFI_RESOURCE_IO_RESERVED 0x00000006
    #define EFI_RESOURCE_MAX_MEMORY_TYPE 0x00000007

    //
    // These types can be ORed together as needed.
    // The first three enumerations describe settings
    //
    #define EFI_RESOURCE_ATTRIBUTE_PRESENT 0x00000001
    #define EFIRESOURCE_ATTRIBUTE_INITIALIZED 0x00000002
    #define EFIRESOURCE_ATTRIBUTE_TESTED 0x00000004

    // The rest of the settings describe capabilities
    //
    #define EFIRESOURCE_ATTRIBUTE_SINGLE_BIT_ECC 0x00000008
    #define EFIRESOURCE_ATTRIBUTE_MULTIPLE_BIT_ECC 0x00000010
    #define EFIRESOURCE_ATTRIBUTE_ECC_RESERVED_1 0x00000020
    #define EFIRESOURCE_ATTRIBUTE_ECC_RESERVED_2 0x00000040
    #define EFIRESOURCE_ATTRIBUTE_READ_PROTECTED 0x00000080
    #define EFIRESOURCE_ATTRIBUTE_WRITE_PROTECTED 0x00001000
    #define EFIRESOURCE_ATTRIBUTE_EXECUTION_PROTECTED 0x00002000
    #define EFIRESOURCE_ATTRIBUTE_READ_PROTECTABLE 0x00040000
    #define EFIRESOURCE_ATTRIBUTE_WRITE_PROTECTABLE 0x00200000
    #define EFIRESOURCE_ATTRIBUTE_EXECUTION_PROTECTABLE 0x00400000


```c
#define EFI_RESOURCE_ATTRIBUTE_READ_ONLY_PROTECTABLE 0x00800000
#define EFI_RESOURCE_ATTRIBUTE_PERSISTABLE 0x01000000
#define EFI_RESOURCE_ATTRIBUTE_MORE_RELIABLE 0x02000000
```

```c
/// HobType of EFI_HOB_GENERIC_HEADER.
///
/// #define EFI_HOB_TYPE_MEMORY_ALLOCATION 0x0002
/// #define EFI_HOB_TYPE_RESOURCE_DESCRIPTOR 0x0003
/// #define EFI_HOB_TYPE_GUID_EXTENSION 0x0004
/// #define EFI_HOB_TYPE_UNUSED 0xFFFE
/// #define EFI_HOB_TYPE_END_OF_HOB_LIST 0xFFFF
```

```c
/// Describes the format and size of the data inside the HOB.
/// All HOBs must contain this generic HOB header.
///
typedef struct {
    UINT16    HobType;
    UINT16    HobLength;
    UINT32    Reserved;
} EFI_HOB_GENERIC_HEADER;
```

```c
/// Describes various attributes of logical memory allocation.
///
typedef struct {
    EFI_GUID              Name;
    EFI_PHYSICAL_ADDRESS  MemoryBaseAddress;
    UINT64                MemoryLength;
    EFI_MEMORY_TYPE       MemoryType;
    UINT8                 Reserved[4];
} EFI_HOB_MEMORY_ALLOCATION_HEADER;
```

```c
/// Describes all memory ranges used during the HOB producer
/// phase that exist outside the HOB list. This HOB type
/// describes how memory is used, not the physical attributes
/// of memory.
///
typedef struct {
    EFI_HOB_GENERIC_HEADER            Header;
    EFI_HOB_MEMORY_ALLOCATION_HEADER  AllocDescriptor;
} EFI_HOB_MEMORY_ALLOCATION;
```
/// Describes the resource properties of all fixed, nonrelocatable resource ranges found on the processor host bus during the HOB producer phase.
EGIN typedef struct {
    EFI_HOB_GENERIC_HEADER Header;
    EFI_GUID Owner;
    EFI_RESOURCE_TYPE ResourceType;
    EFI_RESOURCE_ATTRIBUTE_TYPE ResourceAttribute;
    EFI_PHYSICAL_ADDRESS PhysicalStart;
    UINT64 ResourceLength;
} EFI_HOB_RESOURCE_DESCRIPTOR;
EEND

/// Allows writers of executable content in the HOB producer phase to maintain and manage HOBs with specific GUID.
EGIN typedef struct {
    EFI_HOB_GENERIC_HEADER Header;
    EFI_GUID Name;
} EFI_HOB_GUID_TYPE;
EEND

/// Union of all the possible HOB Types.
EGIN typedef union {
    EFI_HOB_GENERIC_HEADER *Header;
    EFI_HOB_MEMORY_ALLOCATION *MemoryAllocation;
    EFI_HOB_RESOURCE_DESCRIPTOR *ResourceDescriptor;
    EFI_HOB_GUID_TYPE *Guid;
    UINT8 *Raw;
} EFI_PEI_HOB_POINTERS;
EEND
12.8 Firmware Volume and Firmware Filesystem

Please refer to PiFirmwareVolume.h and PiFirmwareFile.h from EDK2 project for original source.

12.8.1 PiFirmwareVolume.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Pi/PiFirmwareVolume.h

/// EFI_FV_FILE_ATTRIBUTES
///
typedef UINT32 EFI_FV_FILE_ATTRIBUTES;

///
/// type of EFI FVB attribute
///
typedef UINT32 EFI_FVB_ATTRIBUTES_2;

typedef struct {
   UINT32  NumBlocks;
   UINT32  Length;
} EFI_FV_BLOCK_MAP_ENTRY;

///
/// Describes the features and layout of the firmware volume.
///
typedef struct {
   UINT8    ZeroVector[16];
   EFI_GUID FileSystemGuid;
   UINT64   FvLength;
   UINT32   Signature;
   EFI_FVB_ATTRIBUTES_2 Attributes;
   UINT16   HeaderLength;
   UINT16   Checksum;
   UINT16   ExtHeaderOffset;
   UINT8    Reserved[1];
   UINT8    Revision;
   EFI_FV_BLOCK_MAP_ENTRY BlockMap[1];
} EFI_FIRMWARE_VOLUME_HEADER;

#define EFI_FVH_SIGNATURE SIGNATURE_32 ('_', 'F', 'V', 'H')

///
/// Firmware Volume Header Revision definition
///
#define EFI_FVH_REVISION  0x02
/// Extension header pointed by ExtHeaderOffset of volume header.
typedef struct {
    EFI_GUID  FvName;
    UINT32    ExtHeaderSize;
} EFI_FIRMWARE_VOLUME_EXT_HEADER;

/// Entry structure for describing FV extension header
typedef struct {
    UINT16    ExtEntrySize;
    UINT16    ExtEntryType;
} EFI_FIRMWARE_VOLUME_EXT_ENTRY;

#define EFI_FV_EXT_TYPE_OEM_TYPE  0x01

/// This extension header provides a mapping between a GUID
/// and an OEM file type.
typedef struct {
    EFI_FIRMWARE_VOLUME_EXT_ENTRY  Hdr;
    UINT32    TypeMask;
} EFI_FIRMWARE_VOLUME_EXT_ENTRY_OEM_TYPE;

#define EFI_FV_EXT_TYPE_GUID_TYPE 0x0002

/// This extension header EFI_FIRMWARE_VOLUME_EXT_ENTRY_GUID_TYPE
/// provides a vendor specific GUID FormatType type which
/// includes a length and a successive series of data bytes.
typedef struct {
    EFI_FIRMWARE_VOLUME_EXT_ENTRY     Hdr;
    EFI_GUID                          FormatType;
} EFI_FIRMWARE_VOLUME_EXT_ENTRY_GUID_TYPE;

12.8.2  PiFirmwareFile.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Pi/PiFirmwareFile.h

/// Used to verify the integrity of the file.
union {
    struct {
        UINT8   Header;
        UINT8   File;
    } Checksum;
    UINT16   Checksum16;
    EFI_FFS_INTEGRITY_CHECK;
};
/**
/// FFS_FIXED_CHECKSUM is the checksum value used when the
/// FFS_ATTRIB_CHECKSUM attribute bit is clear.
///
#define FFS_FIXED_CHECKSUM 0xAA

typedef UINT8 EFI_FV_FILETYPE;
typedef UINT8 EFI_FFS_FILE_ATTRIBUTES;
typedef UINT8 EFI_FFS_FILE_STATE;

///
/// File Types Definitions
///
#define EFI_FV_FILETYPE_FREEFORM 0x02

///
/// FFS File Attributes.
///
#define FFS_ATTRIB_LARGE_FILE 0x01
#define FFS_ATTRIB_FIXED 0x04
#define FFS_ATTRIB_DATA_ALIGNMENT 0x38
#define FFS_ATTRIB_CHECKSUM 0x40

///
/// FFS File State Bits.
///
#define EFI_FILE_HEADER_CONSTRUCTION 0x01
#define EFI_FILE_HEADER_VALID 0x02
#define EFI_FILE_DATA_VALID 0x04
#define EFI_FILE_MARKED_FOR_UPDATE 0x08
#define EFI_FILE_DELETED 0x10
#define EFI_FILE_HEADER_INVALID 0x20

///
/// Each file begins with the header that describe the
/// contents and state of the files.
///
typedef struct {
    EFI_GUID Name;
    EFI_FFS_INTEGRITY_CHECK IntegrityCheck;
    EFI_FV_FILETYPE Type;
    EFI_FFS_FILE_ATTRIBUTES Attributes;
    UINT8 Size[3];
    EFI_FFS_FILE_STATE State;
} EFI_FFS_FILE_HEADER;
typedef struct {
    EFI_GUID                  Name;
    EFI_FFS_INTEGRITY_CHECK   IntegrityCheck;
    EFI_FV_FILETYPE          Type;
    EFI_FFS_FILE_ATTRIBUTES  Attributes;
    UINT8                    Size[3];
    EFI_FFS_FILE_STATE       State;
    UINT32                   ExtendedSize;
} EFI_FFS_FILE_HEADER2;

#define IS_FFS_FILE2(FfsFileHeaderPtr)  
    (((((EFI_FFS_FILE_HEADER *) (UINTN) FfsFileHeaderPtr) - 
        >Attributes) & FFS_ATTRIB_LARGE_FILE) == FFS_ATTRIB_LARGE_FILE)

#define FFS_FILE_SIZE(FfsFileHeaderPtr)  
    ((UINT32) (*((UINT32 *) ((EFI_FFS_FILE_HEADER *) (UINTN) 
        FfsFileHeaderPtr) - Size) & 0x00ffffff))

#define FFS_FILE2_SIZE(FfsFileHeaderPtr)  
    (((EFI_FFS_FILE_HEADER2 *) (UINTN) FfsFileHeaderPtr) - 
        >ExtendedSize)

typedef UINT8 EFI_SECTION_TYPE;
#define EFI_SECTION_RAW              0x19

///
/// Common section header.
///
typedef struct {
    UINT8               Size[3];
    EFI_SECTION_TYPE   Type;
} EFI_COMMON_SECTION_HEADER;

typedef struct {
    UINT8               Size[3];
    EFI_SECTION_TYPE   Type;
    UINT32             ExtendedSize;
} EFI_COMMON_SECTION_HEADER2;

///
/// The leaf section which contains an array of zero or more
/// bytes.
///
typedef EFI_COMMON_SECTION_HEADER   EFI_RAW_SECTION;
typedef EFI_COMMON_SECTION_HEADER2  EFI_RAW_SECTION2;
12.9 Debug Error Level

Please refer to DebugLib.h from the EDK2 project for the original source.

12.9.1 DebugLib.h

https://github.com/tianocore/edk2/blob/master/MdePkg/Include/Library/DebugLib.h

// Declare bits for PcdDebugPrintErrorLevel and the ErrorLevel parameter of DebugPrint()
//
#define DEBUG_INIT 0x00000001 // Initialization
#define DEBUG_WARN 0x00000002 // Warnings
#define DEBUG_LOAD 0x00000004 // Load events
#define DEBUG_FS  0x00000008 // EFI File system
#define DEBUG_POOL 0x00000010 // Alloc & Free (pool)
#define DEBUG_PAGE 0x00000020 // Alloc & Free (page)
#define DEBUG_INFO 0x00000040 // Informational debug messages
#define DEBUG_DISPATCH 0x00000080 // PEI/DXE/SMM Dispatchers
#define DEBUG_VARIABLE 0x00000100 // Variable
#define DEBUG_BM 0x00000400 // Boot Manager
#define DEBUG_BLKIO 0x00001000 // BlkIo Driver
#define DEBUG_NET 0x00004000 // Network Io Driver
#define DEBUG_UNDI 0x00010000 // UNDI Driver
#define DEBUG_LOADFILE 0x00020000 // LoadFile
#define DEBUG_EVENT 0x00080000 // Event messages
#define DEBUG_GCD 0x00100000 // Global Coherency Database changes
#define DEBUG_CACHE 0x00200000 // Memory range cachability changes
#define DEBUG_VERBOSE 0x00400000 // Detailed debug messages that may significantly impact boot performance
#define DEBUG_ERROR 0x80000000 // Error

// Aliases of debug message mask bits
//
#define EFI_D_INIT     DEBUG_INIT
#define EFI_D_WARN     DEBUG_WARN
#define EFI_D_LOAD     DEBUG_LOAD
#define EFI_D_FS       DEBUG_FS
#define EFI_D_POOL     DEBUG_POOL
#define EFI_D_PAGE     DEBUG_PAGE
#define EFI_D_INFO     DEBUG_INFO
#define EFI_D_DISPATCH DEBUG_DISPATCH
#define EFI_D_VARIABLE DEBUG_VARIABLE
#define EFI_D_BM       DEBUG_BM
#define EFI_D_BLKIO    DEBUG_BLKIO
#define EFI_D_NET      DEBUG_NET
#define EFI_D_UNDI     DEBUG_UNDI
#define EFI_D_LOADFILE DEBUG_LOADFILE
#define EFI_D_EVENT    DEBUG_EVENT
#define EFI_D_VERBOSE  DEBUG_VERBOSE
#define EFI_D_ERROR    DEBUG_ERROR